

MAX86160 Evaluation System

Evaluates: MAX86160

General Description

The MAX86160 Evaluation System (EVSYS) allows for the quick evaluation of the MAX86160 optical AFE for applications at various sites on the body, particularly in-ear applications. The MAX86160 supports a standard I²C-compatible interface. MAX86160 consists of two optical readout channels that can operate simultaneously (Green and IR). The EVSYS allows flexible configurations to optimize measurement signal quality at minimal power consumption, and helps the user quickly learn to configure and use the MAX86160.

The EVSYS consists of two circuit boards. The MAXSensorBLE is the main data acquisition board while the MAX86160_Flex_Bd_EVKIT is a sensor rigid-flex board. The EVSYS can be powered using the USB-C supply or LiPo Battery.

The EVSYS comes with a MAX86160EFN+ device in an 18-lead OESIP package.

Features

- Quick Evaluation of the MAX86160
- Supports Optimization of Configurations
- Facilitates Understanding MAX86160 Architecture and Solution Strategy
- Real-time Monitoring
- Data Logging Capabilities
- On-Board Accelerometer
- Bluetooth LE

Ordering Information appears at end of data sheet.

Quick Start

Required Equipment

- MAX86160 EVSYS
- Data Acquisition EVSYS Micro-PCB (MAXSensorBLEEK#)
- MAX86160 EVSYS Sensor PCB (MAX86160OSBEK#)
- Flex cable
- USB-C cable
- MAX86160 EVSYS GUI Software
- MAX86160 Parser and User guide (included in MAX86160GUISetupVxxx.ZIP)
- Windows PC
- Required Bluetooth LE Dongle [CY5677](#) or [CY5670](#) (not shipped with EVSYS)
- Optional LiPo Battery ([LP-401230](#) suggested, not shipped with EVSYS)

Note: If you do not already have one of the listed BLE dongles above, purchasing one is recommended.

Procedure

- 1) The EVSYS is fully assembled and tested. Follow the steps below to verify board operation: Visit www.maximintegrated.com/evkit-software to download the most recent version of the EVSYS software, MAX86160GUISetupVxxx_Web.ZIP. Save the EVSYS software to a temporary folder and decompress the ZIP file.
- 2) Plugged in the BLE dongle to one of the USB port on the PC.
- 3) Open up MAX86160GUISetupVxxx.exe and follow the instructions from the pop-up windows, as shown in [Figure 1](#) to [Figure 7](#).
- 4) The BLE Dongle driver installation also completes after the GUI installation.
- 5) If the MAX86160 EVSYS flex cable is not already connecting the Data Acquisition EVSYS Micro PCB to the MAX86160 Sensor Flex Board, then please connect the two PCBs with the cable as shown in [Figure 8](#) and [Figure 9](#).

- 6) Connect USB-C cable or LiPo Battery to the Data Acquisition Board to power up the EVSYS. If LiPo battery is used, press the power switch (SW) to turn on/off the device. When powered on, the green LED will toggle.
- 7) After that, start the MAX86160 EVSYS GUI program. "Connect Device" will appear, choose your device and press "Connect" as shown in [Figure 10](#).
- 8) The GUI will then be launched as shown in [Figure 11](#).
- 9) Configure the EVSYS on the GUI and Click on the <Start> button on the bottom left side to start the data acquisition.
- 10) When running, the LEDs on the Micro PCB should illuminate and the plots on the GUI should stream with data as shown in [Figure 12](#) and [Figure 13](#).

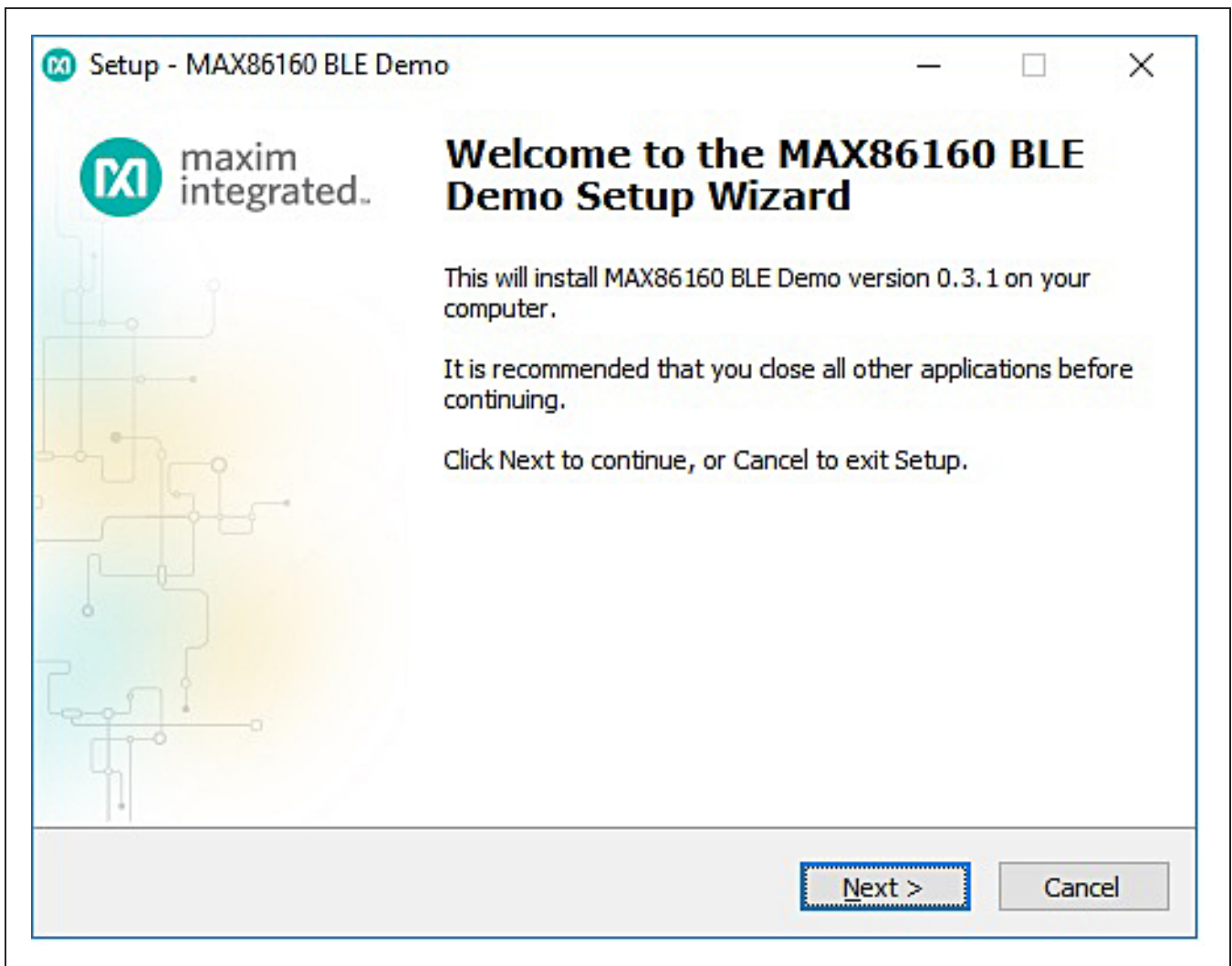


Figure 1. Setup MAX86160 EVSYS GUI Software Step 1

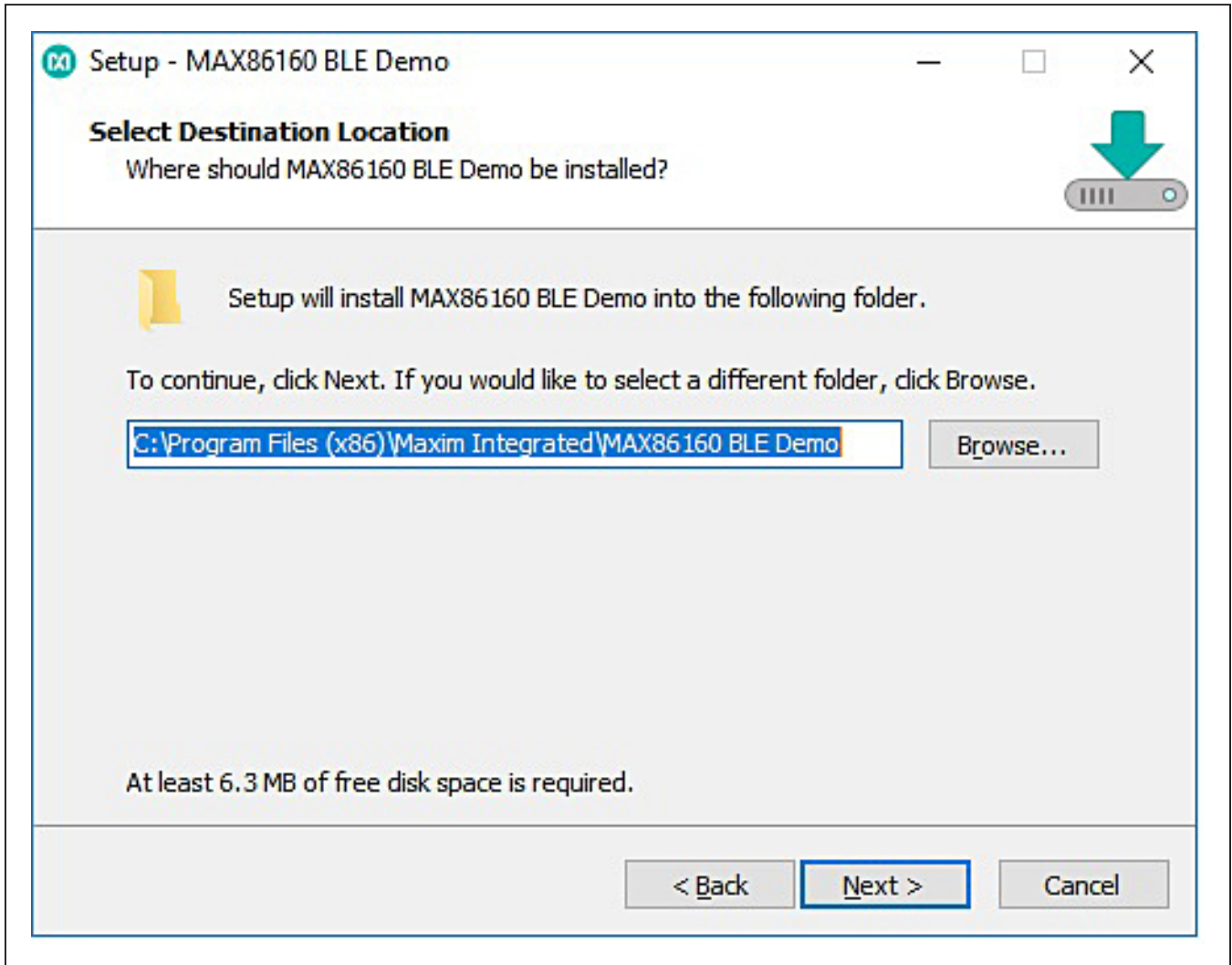


Figure 2. Setup MAX86160 EVSYS GUI Software Step 2

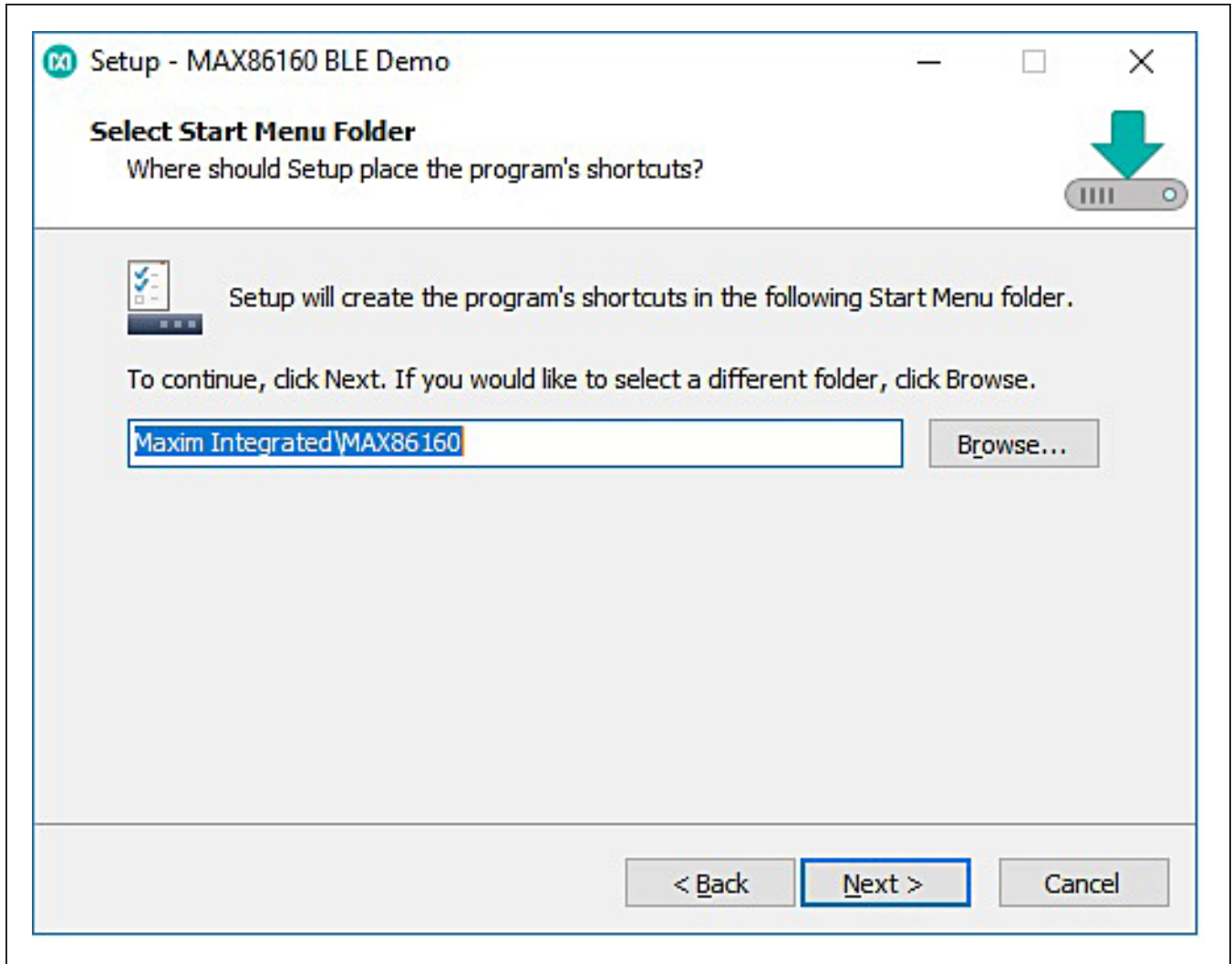


Figure 3. Setup MAX86160 EVSYS GUI Software Step 3

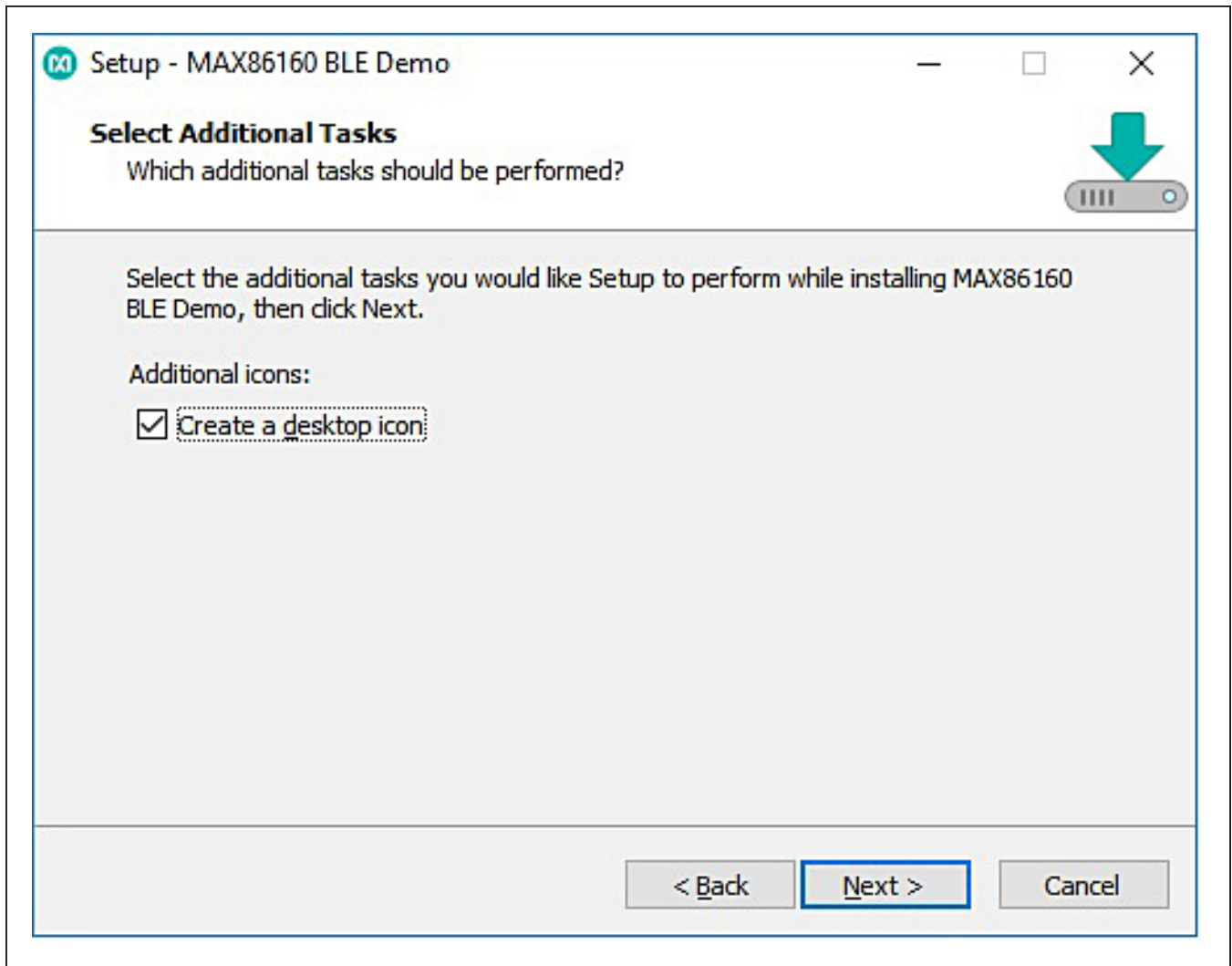


Figure 4. Setup MAX86160 EVSYS GUI Software Step 4

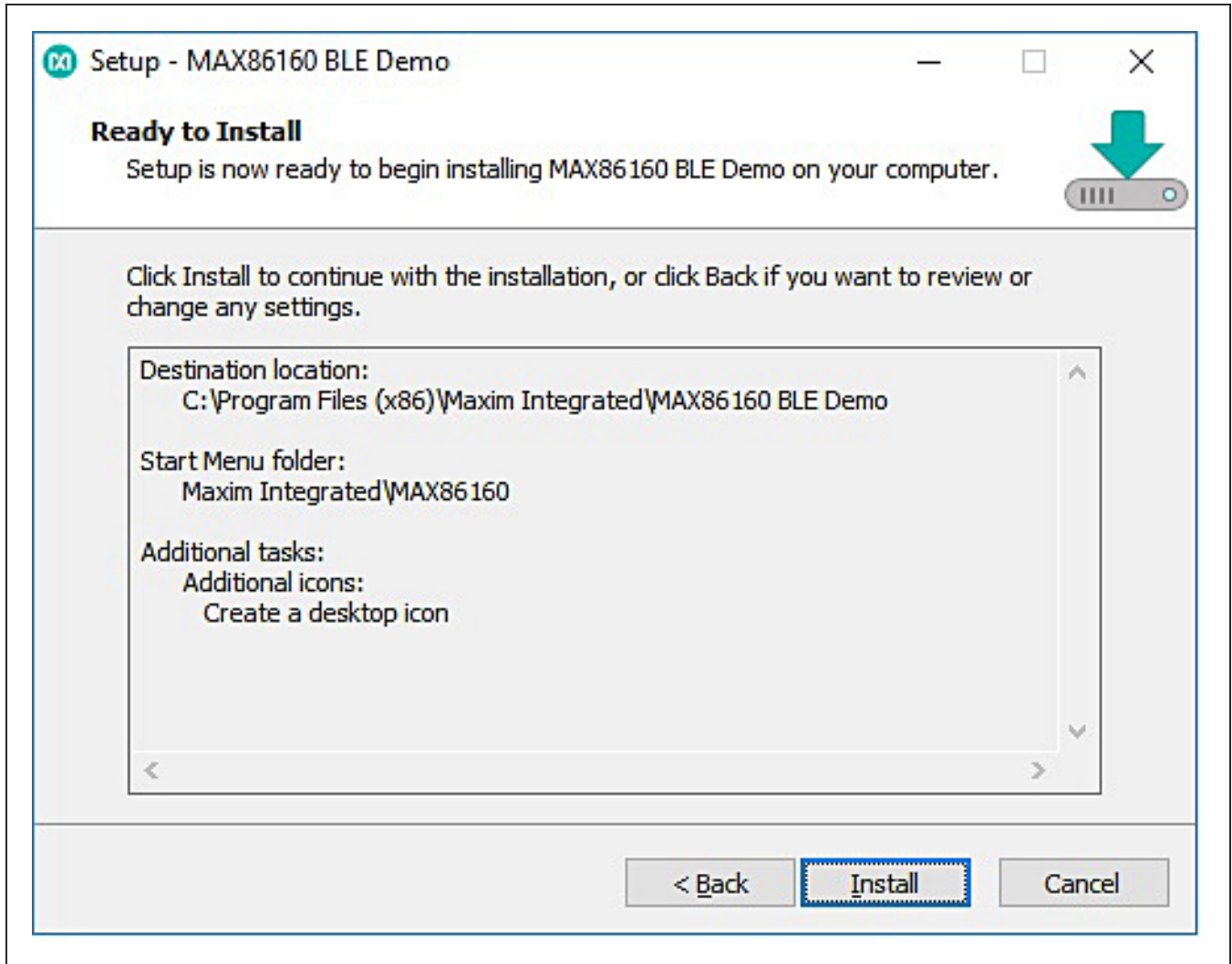


Figure 5. Setup MAX86160 EVSYS GUI Software Step 5

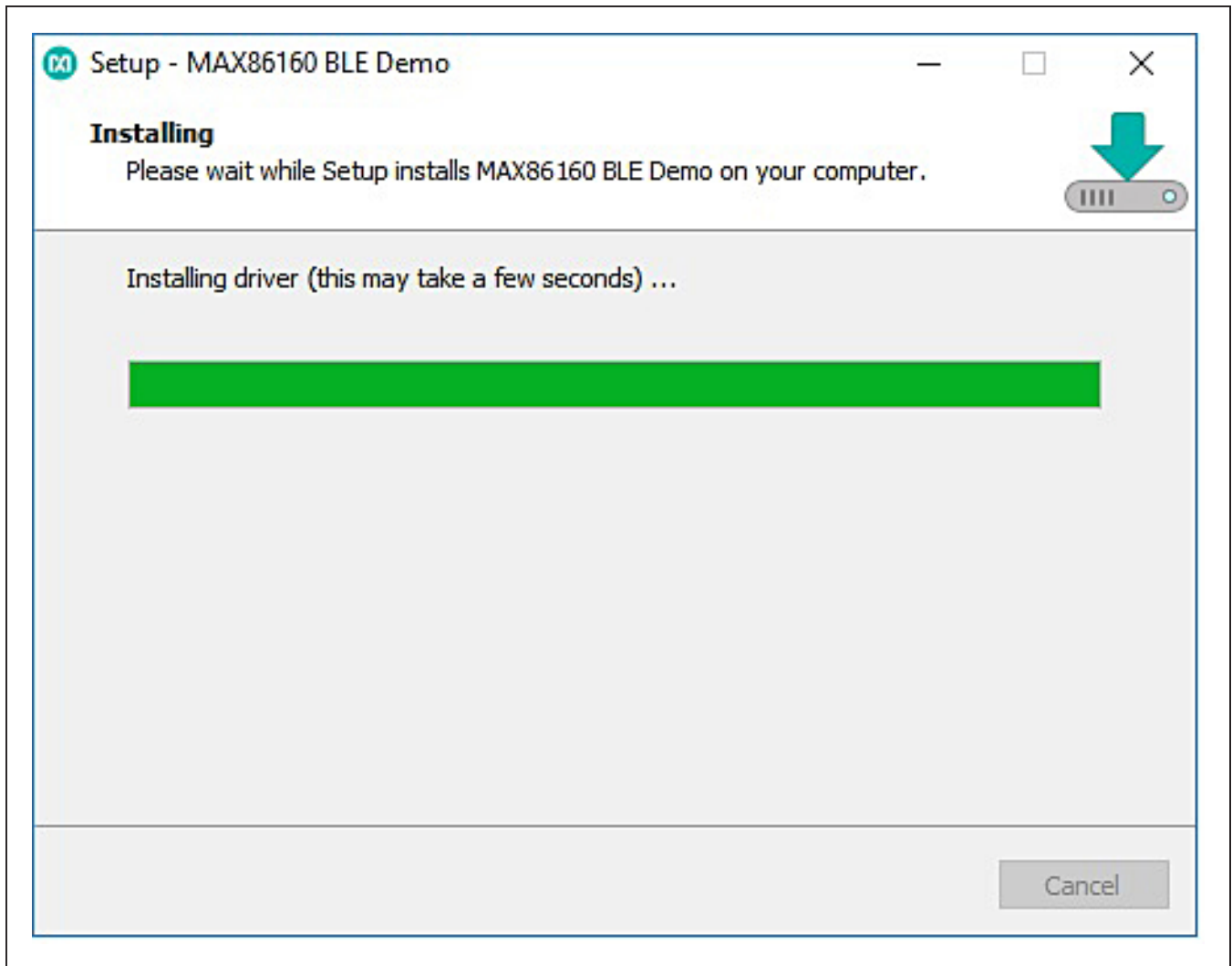


Figure 6. Setup MAX86160 EVSYS GUI Software Step 6

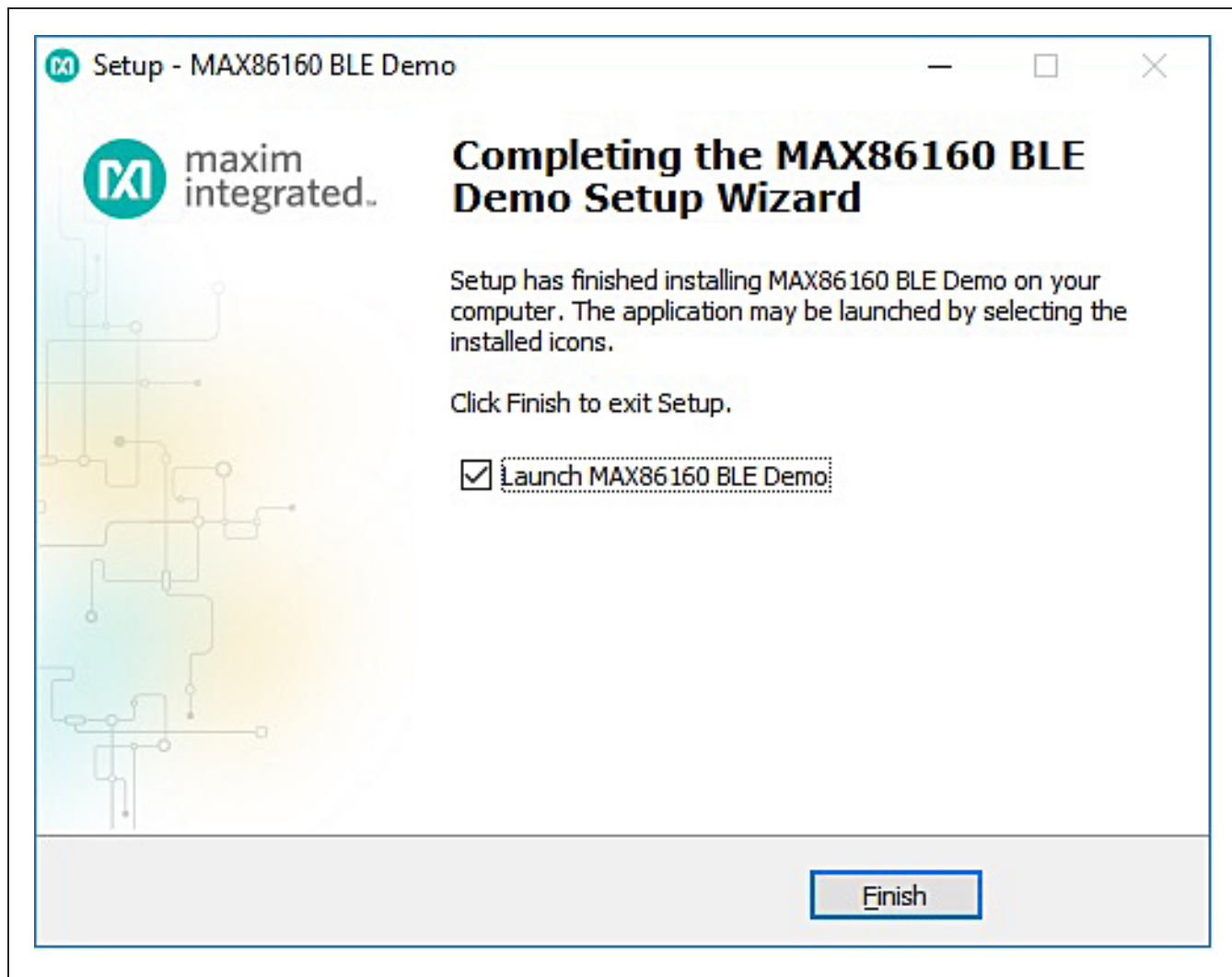


Figure 7. Setup MAX86160 EVSYS GUI Software Step 7

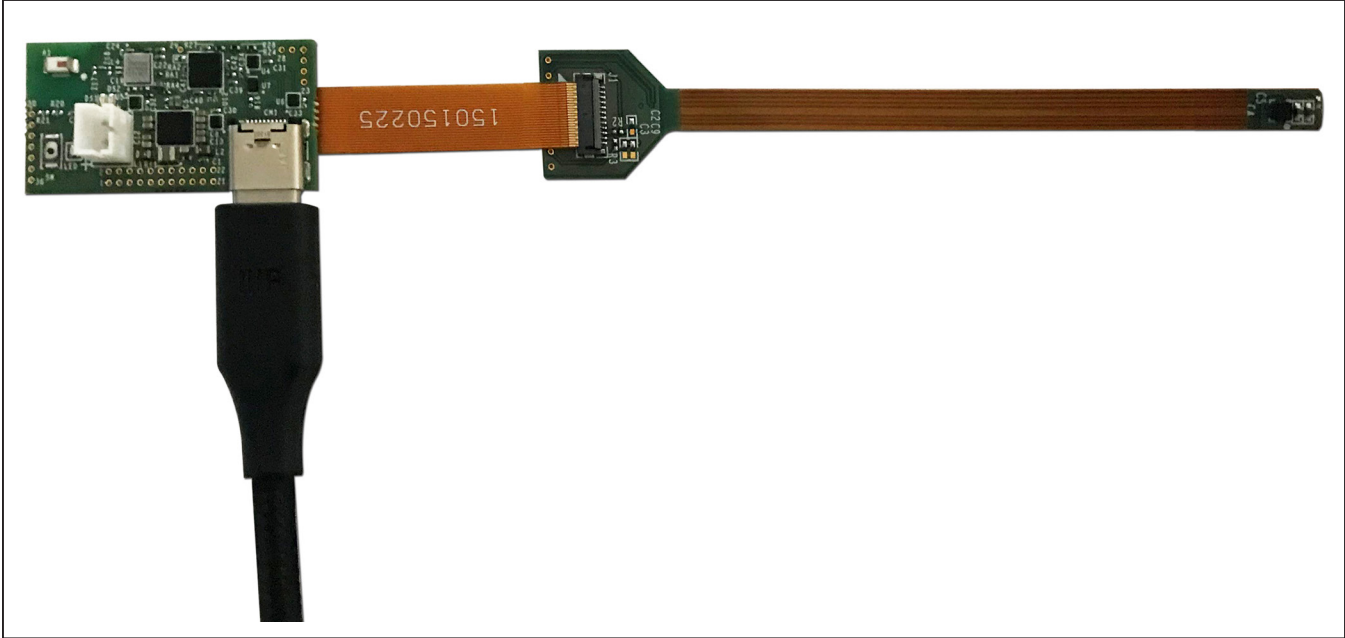


Figure 8. Hardware Setup (MAX86160 EVSYS Micro-PCB)

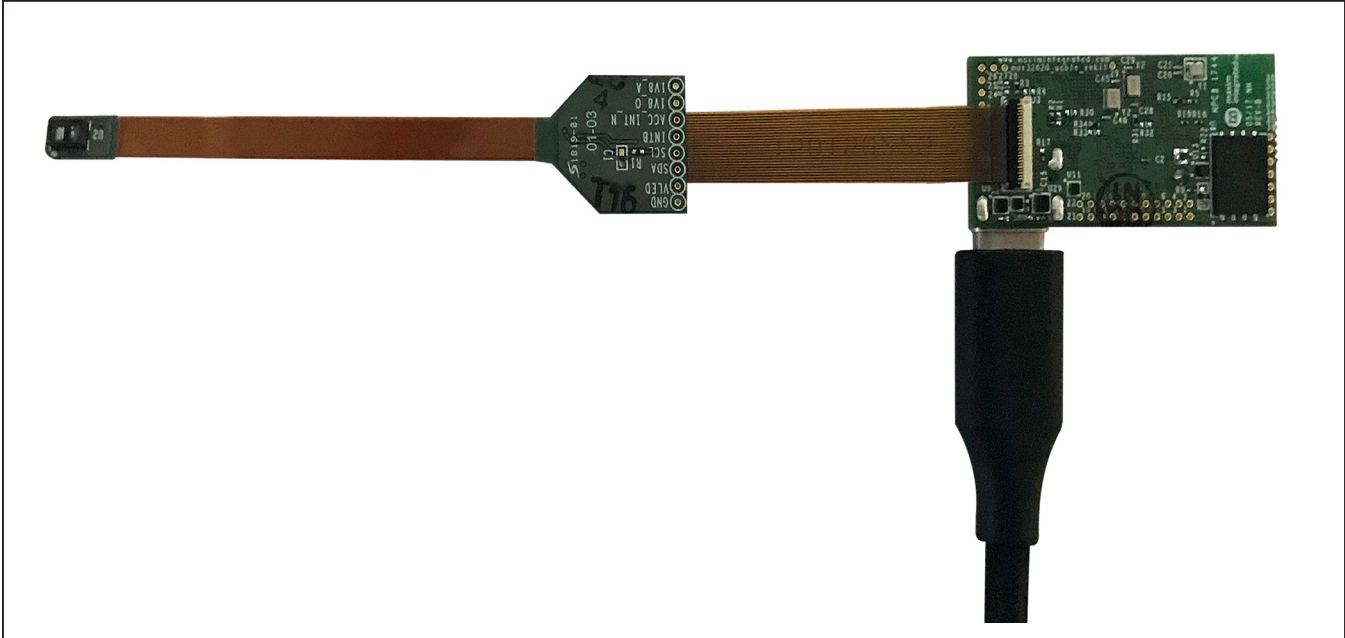


Figure 9. Hardware Setup (MAX86160 EVSYS Sensor PCB)

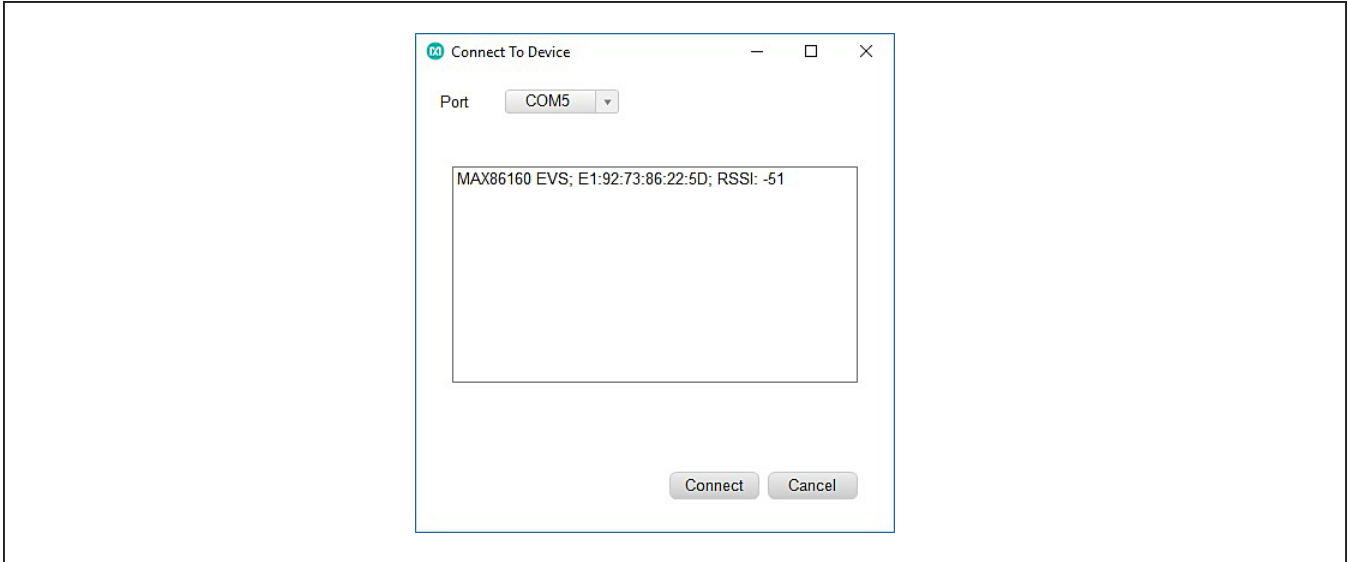


Figure 10. Connect to BLE Device

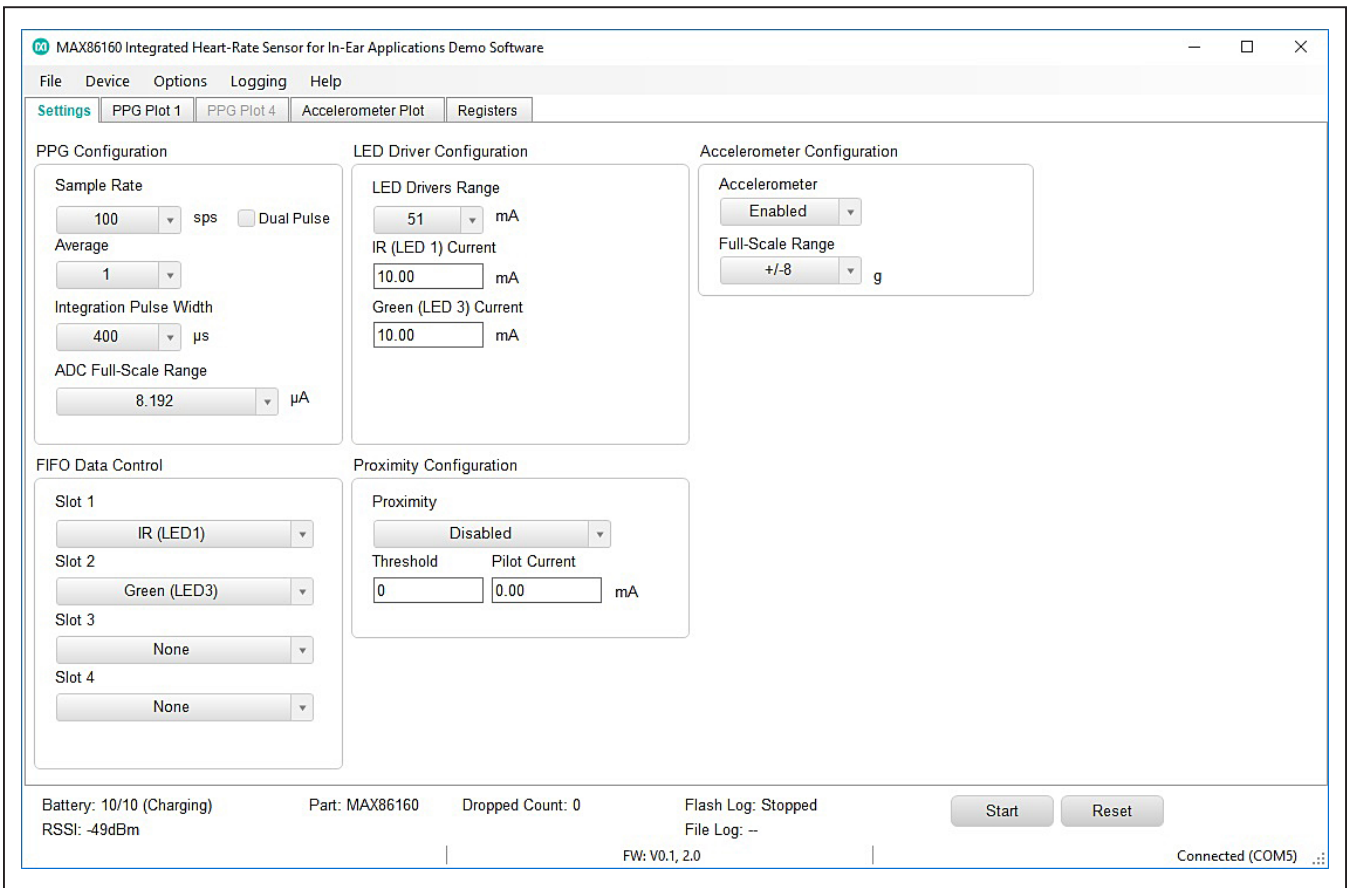


Figure 11. MAX86160 EVSYS GUI

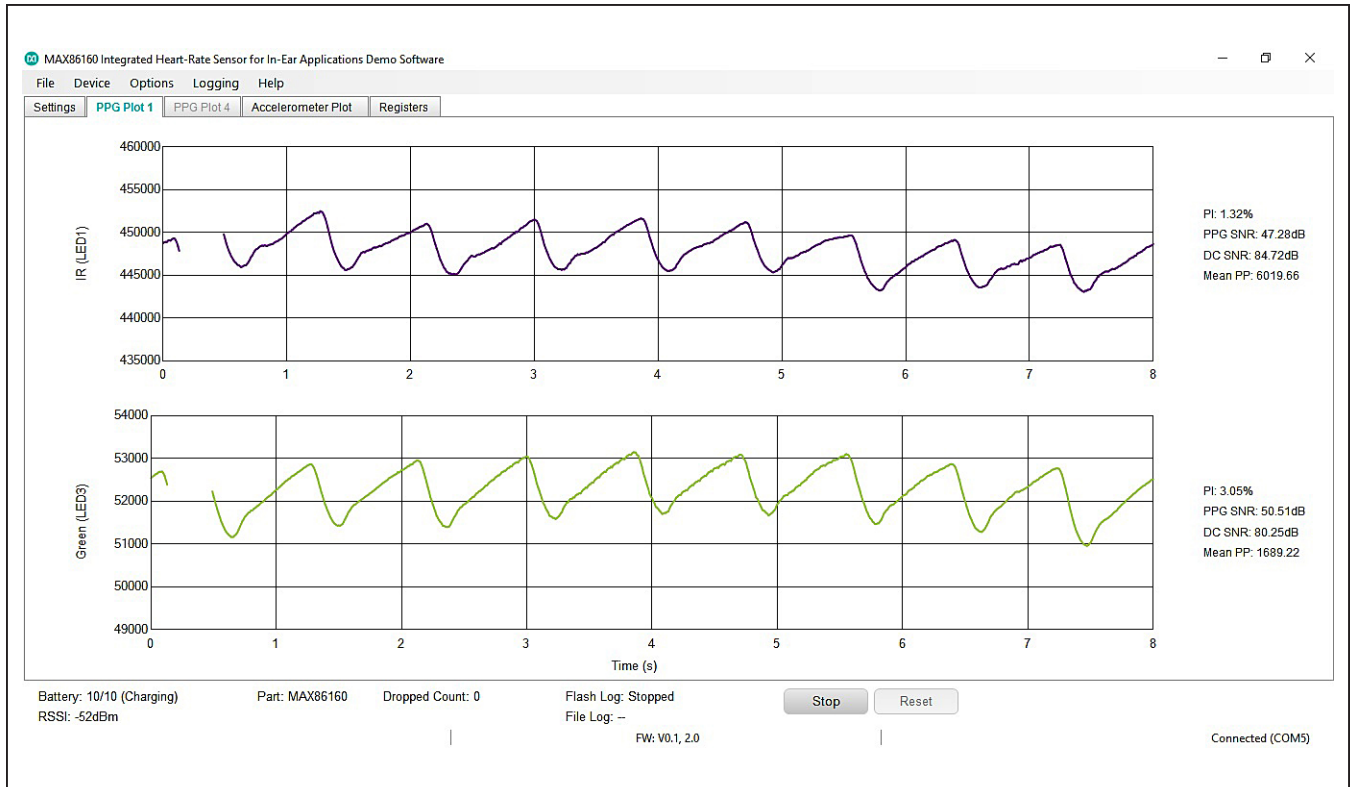


Figure 12. MAX86160 EVSYS GUI (PPG Plots)

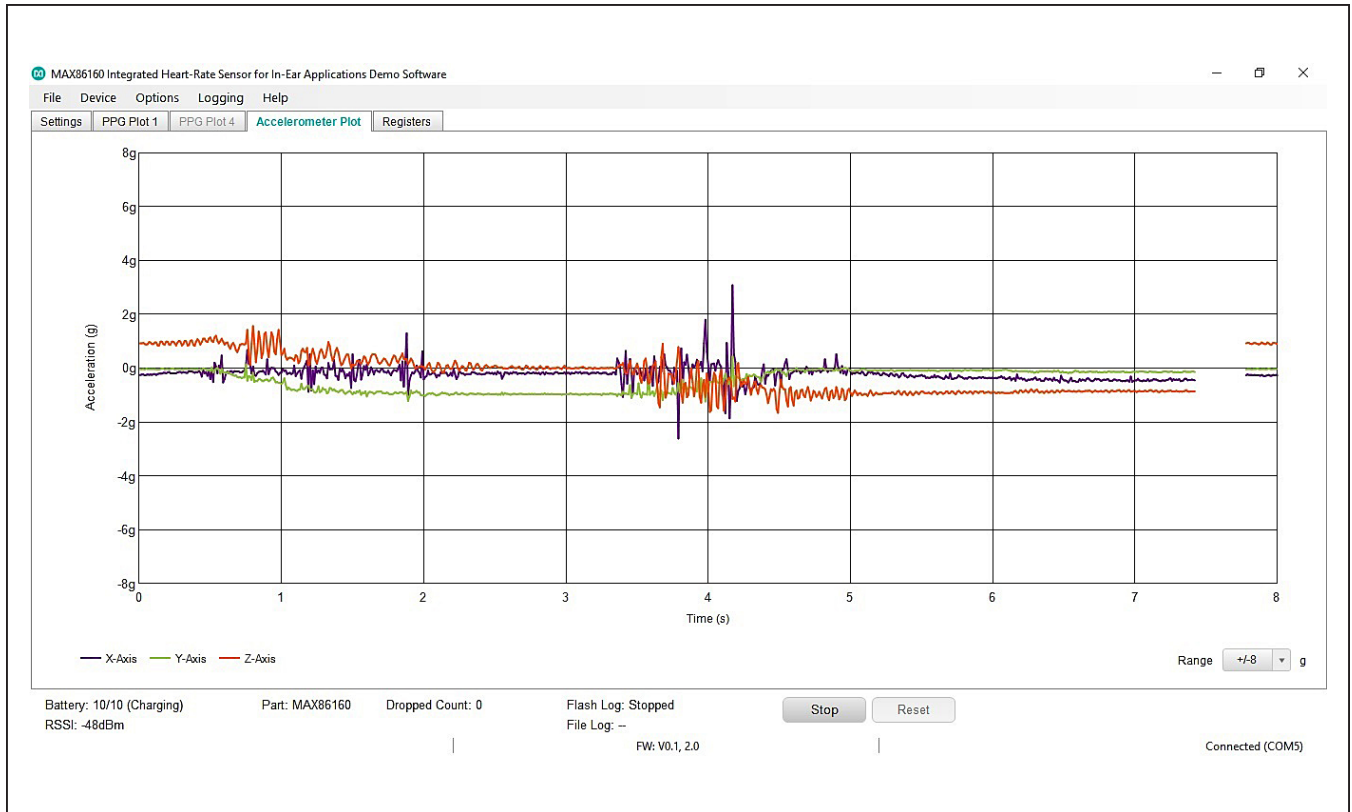


Figure 13. MAX86160 EVSYS GUI (Accelerometer Plots)

Detailed Description of Software

The EVSYS contains two circuit boards: 1) A Flex-Rigid Board that contains the MAX86160 device, an integrated optical system containing two embedded LEDs (Green and IR) and photodiode, with a 3-axis accelerometer, and 2) a MAXSensorBLE board that facilitates data communications and configuration management. The EVSYS allows raw optical and accelerometer data to be sampled and transferred to the GUI for both dynamic viewing and logging for later analysis. The EVSYS microcontroller PCB is used to conduct I²C to BLE communication, transporting the raw optical and accelerometer data to the PC through BLE.

Most of functionality of the MAX86160 has been mapped to the GUI so the wide variety of applications supported by the MAX86160 can be rapidly explored. The following is a brief description of these functions..

Sample Rate

The sample rate can take on values between 10 to 3200Sps. The dual pulse mode option are modes where the samples are unevenly spaced and averaged to improve the ambient rejection of mains line rate ambient signals.

[Table 1](#) shows the maximum supported sampling rates (in Sps) for the MAX86160 for the given number of exposure sequences and use of accelerometer. The maximum sample rate is limited by the BLE protocol, not the AFE itself.

For a given sample rate, the number listed can be increased to the next available MAX86160 sample rate (i.e., 500Sps → 512Sps).

Integration Pulse Width

The pulse width setting adjusts the integration time of an exposure. The MAX86160 supports exposure integration times of 50µs, 100µs, 200µs and 400µs. The exposure pulse width is a critical parameter in any optical measurement. Longer exposures allow for more optical photons to be integrated but also increase system power and reduce ambient rejection capability.

Ambient Light Cancellation

The on-chip Ambient Light Cancellation incorporates a proprietary scheme to cancel ambient light generated photo diode current, allowing the sensor to work in high ambient light conditions.

ADC Full-Scale Range

The MAX86160 optical channel has 4 full-scale ranges. These ranges are 4µA (4.096µA), 8µA (8.192µA), 16µA (16.384µA), and 32µA (32.768µA).

Sample Average

The MAX86160 has the capability to do sample averaging of 1~32 samples internally. This feature is useful if more optical energy is needed to make a low perfusion measurement but the data rate across the interface or the processing power in a host micro is not desirable. This mode is also useful to further suppress the mains line noises in indoor lighting conditions.

LED Sequence Control (FIFO Time Slots)

The LED Sequence Control specifies the data acquisition sequence that the internal state machine controller will follow and where the converted data will be mapped into the FIFO.

Each FIFO field can be applied to one measurement. Acquired data can be from LED1 or LED3 (optical exposure from LED1 or LED3) illuminated independently. The None option skips the acquisition. LED2 and LED 4 are not supported with the Flex-Cable sensor board. If a custom sensor board with MUX is used, LED2 and LED4 can be configured. Only LED1 and LED3 are available in this EVSYS.

The default exposure sequence is the entry in the Sequence 1 (LEDC1) slot, Sequence 3 (LEDC3), and Sequence 4 (LEDC4). This sequence repeats for each sample instance.

Please refer to the MAX86160 datasheet under FIFO Configuration Section for details.

Table 1. MAX86160 Max Sample Rates (Sps)

ACCELEROMETER # OF SEQUENCES	WITH	WITHOUT
	1	500
2	500	1000
3	250	500
4	250	500

LED Driver Configurations

Each of the three LED drivers has a Range and Peak LED Current setting. There are 4 full-scale range settings 51mA, 102mA, 153mA, and 204mA. Each range has an 8-bit current source DAC. The Peak LED Current box allows for an actual current to be entered. The nearest available DAC current is selected and displayed in the field.

Accelerometer Configuration

The on-board accelerometer can be enabled or disabled by using the GUI. Supported accelerometer Full-Scale Range are $\pm 2g$, $\pm 4g$, $\pm 8g$, and $\pm 16g$.

Proximity Configuration

The optical controller also includes an optical proximity function which could significantly reduce energy consumption and extend battery life when the sensor is not in contact with the skin.

Please refer to the MAX86160 datasheet under Proximity Mode Section for details.

<Start >/<Stop > Button

The <Start Monitor> button is used to start data acquisition from the demo. The <Start Monitor> button will only be effective when the EVSYS is connected and detected. Once the <Start > has been pushed the <Stop> button appears, which can be used to stop the acquisition. Once the acquisition has started, all settings are locked. Terminate the acquisition to change any settling.

<Reset> Button

The <Reset> button will clear out all register settings back to the programs start up.

Data Logging

Raw optical and accelerometer data can be logged from the <Logging> pull-down menu item. There are two options available: Data saved to file or in the flash. When "file" data logging is selected, the GUI asks for a folder location where the logging file will be saved. Create a new folder or accept the default. Data logging will start on

the next <Start> button and will continue until the <Stop > button is pressed. The final file write is only done when the <File> pull-down menu item is accessed and the data-logging button is pressed.

Flash logging allows raw sensor data to be stored to the integrated 32MB flash memory chip in a binary file format. The max duration for flash logging is dependent on: sample rate, number of optical channels, and use of accelerometer.

The GUI enables/disables flash logging. The GUI can be disconnected while flash logging, allowing for remote operation (PPG Plots not available). Preparing the flash memory can take up to 30s after enabling. If the flash memory fills or battery power drops too low, flash logging will automatically stop and the file will close. Only one file can be saved at a time. The file must be downloaded since it will be erased on the next log request.

If a log has completed, a binary file will be found on the device. The binary log file must be downloaded via the USB-C cable; it cannot be downloaded through BLE. When the device is plugged into the PC, it enumerates as a USB mass storage device. However, the file can only be copied from this device. No other operations (such as deleting or saving other files) will work on this device. Copy the file to a local PC volume. Then run the parser to generate a CSV file.

Please refer to the Evaluation Kit Parser User Guide (max8614x demo + eval kit parser user guide 20170719.pdf) for details operation.

Register Map Access

Under the <Register> Tab the user can access to sensor register map as shown in [Figure 14](#). Press <Read All>, to read all the register value currently in configured in the Optical AFE. Bolded font bits are logic one. Normal font bits are logic zero. Click on the bits to toggle their value and click on <W> to write the value to the device. The register value does not change until <W> is clicked. Click <R> to read the register value to verify the write.

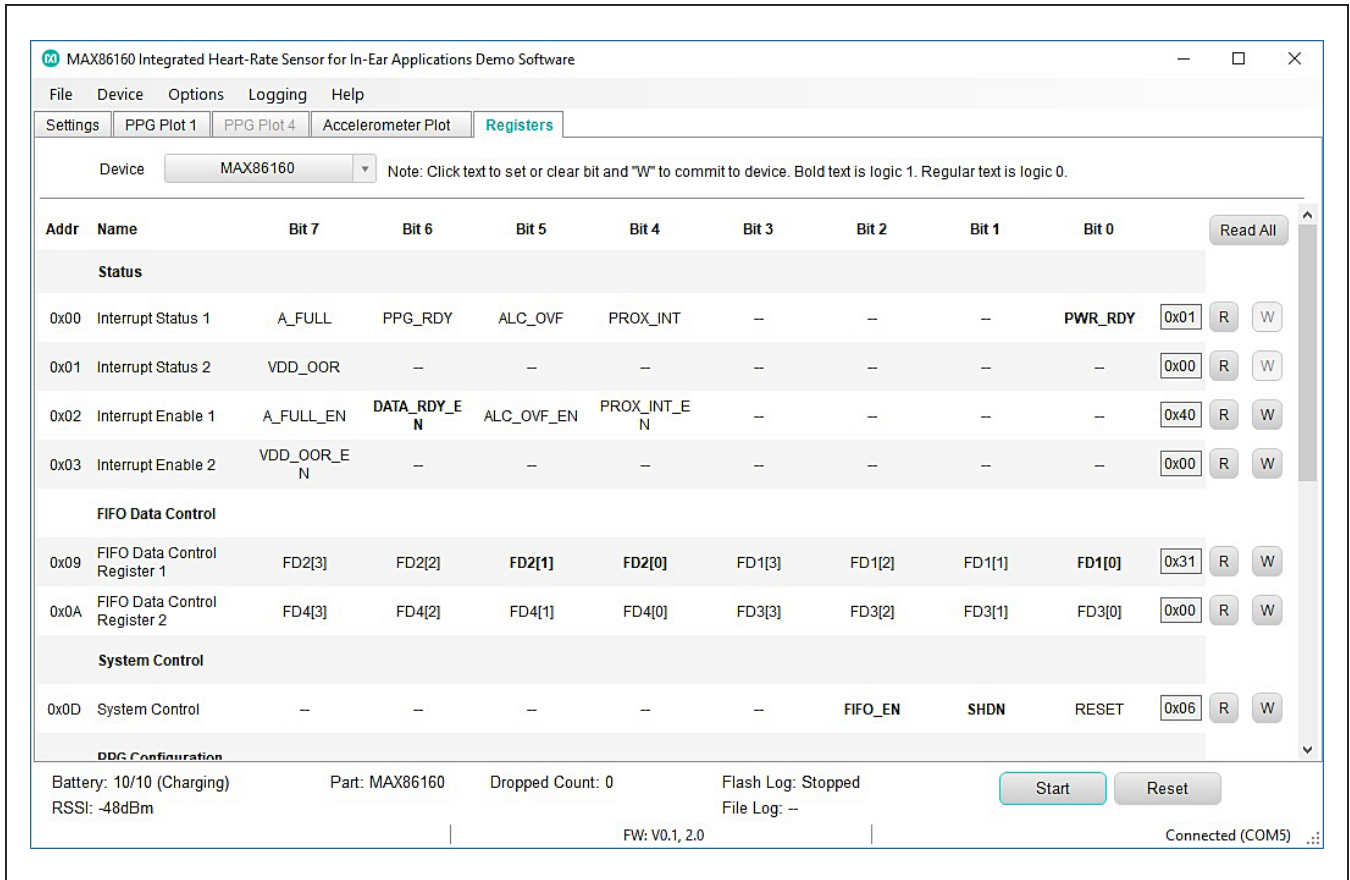


Figure 14. Register Map Access

Detailed Description of Hardware

Status LED Indicators

The onboard tri-color LEDs are use as status indicator.

LED Green

Toggling (1Hz 50% duty cycle) = BLE advertising

Toggling (1Hz 10% duty cycle) = BLE connected

LED Red

USB-C cable connected to charger

On = charging

Off = charge complete

Flash Logging

On = busy preparing the flash memory or flash memory is full

Toggling (synchronously with the green LED) = logging

Off = not logging

Ordering Information

PART	TYPE
MAX86160EVSYS#	EVSYS

#Denotes RoHS compliant.

Note that flash logging indication takes precedence over the charging indication. I.e., if the device is plugged into a charger, the red LED indicates charge status. If flash logging is enabled while plugged into the charger, the red LED indicates flash log status.

Power Switch

Press the power switch (SW) to turn on/off the device. When powered on, the green LED will toggle per the LED indicator section. When powered off, the green LED will go out. The red LED may light temporarily, indicating that the flash log is closing. Plugging in the USB-C cable will also power up the device.

Battery/Charging

Use the USB-C cable to charge the integrated single-cell LiPo battery. The integrated PMIC initiates and stops charging automatically. Charge status is indicated through the red LED and GUI.

Component List

MAX86160 EVSYS

PART	QTY	DESCRIPTION
MAXSensorBLE_EVKIT	1	MAX86160 EVSYS μ C PCB
MAX86160_FLEX_BD_EVKIT	1	Optical Sensor Flex-Rigid Board
150150225	1	Molex, Flex Cable, 25 Pins
CY5677	1	Cypress, BLE Dongle
101181XX-000XXX	1	USB-C to USB-A Cable, 3 Ft.

MAX86160 EV Kit Bill of Materials

MAXSENSORBLEEK#

ITEM	REF_DES	DNI/DNP	QTY	MFG PART #	MANUFACTURER	VALUE	DESCRIPTION	COMMENTS
1	A1	-	1	2450AT18A100	JOHANSON TECHNOLOGY	2450AT18A100	ANTENNA; 2450AT SERIES; BOARDMOUNT; MINI 2.45 GHZ ANTENNA; 2450MHZ	
2	BAT	-	1	B2B-PH-K-S(LF)(SN)	JST MANUFACTURING	B2B-PH-K-S(LF)(SN)	CONNECTOR; MALE; THROUGH HOLE; PH CONNECTOR; 2MM PITCH; SHROUDED HEADER; STRAIGHT; 2PINS	
3	C1, C22, C26, C30-C37	-	11	GRM033R61A104KE15; LMK063BJ104KP	MURATA;TAIYO YUDEN	0.1UF	CAPACITOR; SMT (0201); CERAMIC CHIP; 0.1UF; 10V; TOL=10%; MODEL=; TG=-55 DEGC TO +125 DEGC; TC=X5R	
4	C2, C15, C25, C38-C43	-	9	GRM033R61A105ME15	MURATA	1UF	CAPACITOR; SMT (0201); CERAMIC CHIP; 1UF; 10V; TOL=20%; TG= -55 DEGC TO +85 DEGC; TC=X5R	
5	C3, C4, C8, C9, C12, C16, C27	-	7	C1005X5R1A475M050BC	TDK	4.7UF	CAPACITOR; SMT (0402); CERAMIC CHIP; 4.7UF; 10V; TOL=20%; MODEL=C SERIES; TG=-55 DEGC TO +85 DEGC; TC=X5R	
6	C5-C7, C10, C13, C14, C47	-	7	GRM155R60J226ME11	MURATA	22UF	CAPACITOR; SMT (0402); CERAMIC CHIP; 22UF; 6.3V; TOL=20%; TC=X5R	
7	C19	-	1	GJM0335C1E1R0WB01	MURATA	1PF	CAPACITOR; SMT (0201); CERAMIC CHIP; 1PF; 25V; TOL=0.05PF; TG=-55 DEGC TO +125 DEGC; TC=C0G	
8	C20, C21, C28, C29, C45, C46, Z44	-	7	GRM0335C1H120GA01	MURATA	12PF	CAPACITOR; SMT (0201); CERAMIC CHIP; 12PF; 50V; TOL=2%; TG=-55 DEGC TO +125 DEGC; TC=C0G	
9	C23, C24	-	2	GRM0335C1H101JA01	MURATA	100PF	CAPACITOR; SMT (0201); CERAMIC CHIP; 100PF; 50V; TOL=5%; TG=-55 DEGC TO +125 DEGC; TC=C0G	
10	CN1	-	1	DX07S024JJ3	JAE ELECTRONIC INDUSTRY	DX07S024JJ3	CONNECTOR; FEMALE; SMT; USB TYPE-C CONNECTOR; DX07 SERIES RECEPTACLE; RIGHT ANGLE; 24PINS	
11	DS1, DS2	-	2	SML-P11UTT86	ROHM	SML-P11UTT86	DIODE; LED; SMT; PIV=1.8V; IF=0.02A	
12	J3	-	1	5035662500	MOLEX	5035662500	CONNECTOR; FEMALE; SMT; EASY-ON TYPE HOUSING ASSEMBLY; RIGHT ANGLE; 25PINS	
13	L1, L2	-	2	DFM18PAN2R2MGOL	MURATA	2.2UH	INDUCTOR; SMT (0603); CERAMIC CHIP; 2.2UH; TOL=+/-20%; 1.1A;	
14	L3	-	1	DFE201610E-4R7M=P2	MURATA	4.7UH	INDUCTOR; SMT (2016); METAL ALLOY CHIP; 4.7UH; TOL=+/-20%; 1.3A	
15	L4	-	1	LQP03HQ3N3B02	MURATA	3.3NH	INDUCTOR; SMT (0201); FILM TYPE; 3.3NH; TOL=+/-0.1nH; 0.5A	
16	LED	-	1	SML-LX0404SIUPGUSB	LUMEX OPTOCOMPONENTS INC	SML-LX0404SIUPGUSB	DIODE; LED; SML; FULL COLOR; WATER CLEAR LENS; RED-GREEN-BLUE; SMT; VF=2.95V; IF=0.1A	
17	R2, R3, R11, R15, R24, R27-R31, R34	-	11	ERJ-2GEOR00X	PANASONIC		RESISTOR; 0402; 0 OHM; 0%; JUMPER; 0.10W; THICK FILM	
18	R5, R9	-	2	ERJ-1GEF1002C	PANASONIC	10K	RESISTOR; 0201; 10K OHM; 1%; 200PPM; 0.05W; THICK FILM	
19	R6, R7, R16, R17, R23, R25, R26	-	7	ERJ-1GEF4701C	PANASONIC	4.7K	RESISTOR; 0201; 4.7K OHM; 1%; 100PPM; 0.05W; THICK FILM 3-LAYER ELECTRODE	
20	R8	-	1	ERJ-1GEF3902C	PANASONIC	39K	RESISTOR; 0201; 39K OHM; 1%; 100PPM; 0.05W; THICK FILM 3-LAYER ELECTRODE	

MAX86160 EV Kit Bill of Materials (continued)

MAXSENSORBLEEK#

ITEM	REF_DES	DNI/DNP	QTY	MFG PART #	MANUFACTURER	VALUE	DESCRIPTION	COMMENTS
21	R10	-	1	NCP15XH103F03RC	MURATA	10K	THERMISTOR; SMT (0402); THICK FILM (NICKEL PLATED); 10K; TOL=+/-1%	
22	R13	-	1	ERJ-1GEF2613C	PANASONIC	261K	RESISTOR; 0201; 261K OHM; 1%; 200PPM; 0.05W; THICK FILM	
23	R14	-	1	CRCW0201100KFK	VISHAY DALE	100K	RESISTOR; 0201; 100K OHM; 1%; 100PPM; 0.05W; THICK FILM	
24	R18, R19	-	2	ERJ-1GEF2000C	PANASONIC	200	RESISTOR; 0201; 200 OHM; 1%; 200PPM; 0.05W; THICK FILM	
25	RA1-RA4	-	4	ERJ-1GEF33R0C	PANASONIC	33	RESISTOR; 0201; 33 OHM; 1%; 100PPM; 0.05W; THICK FILM 3-LAYER ELECTRODE	
26	SW	-	1	EVP-AWCD2A	PANASONIC	EVP-AWCD2A	SWITCH; SPST; SMT; STRAIGHT; 15V; 0.02A; EVP-AW SERIES	
27	U1	-	1	MAX20303	MAXIM	MAXIM SENSOR PLATFORM 2	EVKIT PART- IC; WEARABLE POWER MANAGEMENT SOLUTION; PACKAGE OUTLINE; WLP 56 PINS; 0.5MM PITCH; PKG. CODE: W563A4+1; PKG. OUTLINE: 21-100104;	
28	U2	-	1	NRF52832-CIAA	NORDIC SEMICONDUCTOR	NRF52832-CIAA	IC; SOC; MULTIPROTOCOL BLUETOOTH LOW ENERGY; ANT; 2.4GHZ RF SOC; WLCSP50	
29	U3-U6, U9	-	5	MAX14689EWL+	MAXIM	MAX14689EWL+	IC; ASW; 0.125A; FREQUENCY-SELECTSBLE; SWITCHED-CAPACITOR VOLTAGE CONVERTER; WLP9 1.2X1.2	
30	U7	-	1	IP4221CZ6-S	NXP	IP4221CZ6-S	IC; PROT; ESD PROTECTION FOR HIGH-SPEED INTERFACE; XSON6	
31	U8	-	1	S25F5256SAGNF001	SPANSION	S25F5256SAGNF001	IC; MMRY; MIRRORBIT FLASH; NON-VOLATILE MEMORY; 1.8V SINGLE SUPPLY WITH CMOS I/O; SERIAL PERIPHERAL INTERFACE WITH MULTI-I/O; WSON8-EP	
32	U10, U11	-	2	MAX9062EBS+G45	MAXIM	MAX9062EBS+G45	IC; COMP; ULTRA-SMALL; LOW-POWER SINGLE COMPARATOR; UCSP4	
33	U12	-	1	MAX32620IWG+	MAXIM	MAX32620IWG+	IC; UCON; HIGH-PERFORMANCE; ULTRA-LOW POWER CORTEX-M4F MICROCONTROLLER FOR RECHARGEABLE DEVICES; WLP81	
34	U13	-	1	74AUP1G97GF	NXP	74AUP1G97GF	IC; LOGC; LOW-POWER CONFIGURABLE MULTIPLE FUNCTION GATE; XSON6	
35	U29	-	1	MAX1819EBL50+	MAXIM	MAX1819EBL50+	IC; VREG; 500MA LOW-DROPOUT LINEAR REGULATOR IN UCSP; UCSP6	
36	X2, Y2	-	2	ECS-.327-6-12	ECS INC	32.768KHZ	CRYSTAL; SMT 2.0 MM X 1.2 MM; 6PF; 32.768KHZ; +/-20PPM; -0.03PPM/DEGC2	
37	Y1	-	1	US3200005Z	PERICOM SEMICONDUCTOR	32MHZ	CRYSTAL; SMT 1.6 MM X 1.2MM; 8PF; 32MHZ; +/-10PPM; +/-10PPM	
38	PCB	-	1	MAXSENSORBLE	MAXIM	PCB	PCB:MAXSENSORBLE	-
39	MISC1	DNI	1	101181XX-000XXX	N/A	101181XX-000XXX	CONNECTOR; MALE; PALETTE SERIES 3.0 USB-C TO USB-A; 3FT BLACK	
40	R1, R4, R12, R20-R22, R32, R33	DNP	0	ERJ-2GEOR00X	PANASONIC	0	RESISTOR; 0402; 0 OHM; 0%; JUMPER; 0.10W; THICK FILM	
41	Z17	DNP	0	GJM0335C1E1ROWB01	MURATA	1PF	CAPACITOR; SMT (0201); CERAMIC CHIP; 1PF; 25V; TOL=0.05PF; TG=-55 DEGC TO +125 DEGC; TC=COG	
42	Z18	DNP	0	250R05L1R8AV4	JOHANSON TECHNOLOGY	1.8PF	CAPACITOR; SMT (0201); MICROWAVE; 1.8PF; 25V; TOL=0.05PF; TG=-55 DEGC TO +125 DEGC; TC=COG	
43	Jan-36	DNP	0	N/A	N/A	N/A	TEST POINT; PAD DIA=0.762MM; BOARD HOLE=0.381MM	
TOTAL			105					

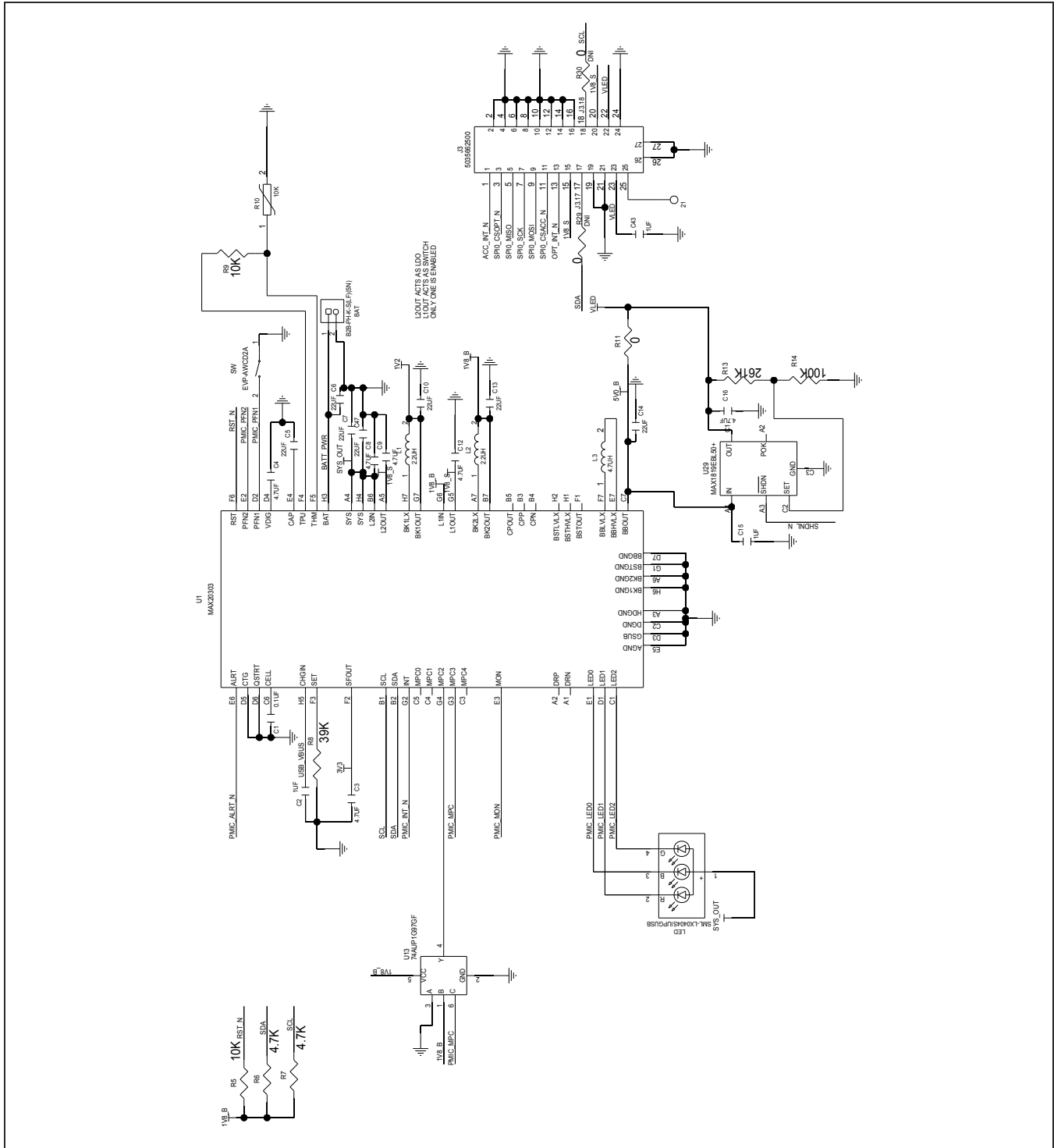
MAX86160 EV Kit Bill of Materials (continued)

MAX86160_Flex_Bd_EVKIT

ITEM	REF_DES		QTY	MFG PART #	MANUFACTURER	VALUE	DESCRIPTION
1	C1-C3, C9		4	04026D226MAT2A	AVX	22UF	CAPACITOR; SMT (0402); CERAMIC CHIP; 22UF; 6.3V; TOL = 20%; TG = -55°C TO +85°C; TC = X5R
2	C4, C6		2	C0402C475M7PAC; GRM155R60G475M; GRM155R60J475ME47	KEMET; MURATA; MURATA	4.7UF	CAPACITOR; SMT; 0402; CERAMIC; 4.7uF; 4V; 20%; X5R; -55°C to + 85°C
3	C5		1	GRM033R61A105ME15	MURATA	1UF	CAPACITOR; SMT (0201); CERAMIC CHIP; 1UF; 10V; TOL = 20%; TG = -55°C TO +85°C; TC = X5R
4	J1		1	5016162575	MOLEX	5016162575	CONNECTOR; FEMALE; SMT; EASY-ON TYPE FPC CONNECTOR; RIGHT ANGLE; 25PINS
5	R1-R3		3	CRCW02010000ZS; ERJ-1GNOR00C	VISHAY DALE; PANASONIC	0	RESISTOR; 0201; 0Ω; 0%; JUMPER; 0.05W; THICK FILM
6	U1		1	LIS2DH	ST MICROELECTRONICS	LIS2DH	IC; MEMS; MEMS DIGITAL OUTPUT MOTION SENSOR; ULTRA LOW-POWER HIGH PERFORMANCE 3-AXIS FEMTO ACCELEROMETER; LGA14 2X2
7	U2		1	MAX86160EFN+	MAXIM	MAX86160EFN+	IC; MOD; INTEGRATED HEART-RATE SENSOR FOR IN-EAR APPLICATION; OLGA18
8	PCB		1	MAX86160FLEXBD	MAXIM	PCB	PCB:MAX86160FLEXBD
9	1V8_A, 1V8_Q, ACC_INT_N, GND, INTB, SCL, SDA, VLED	DNP	0	N/A	N/A	N/A	TEST POINT; PAD DIA = 0.762MM; BOARD HOLE = 0.381MM
TOTAL			14				

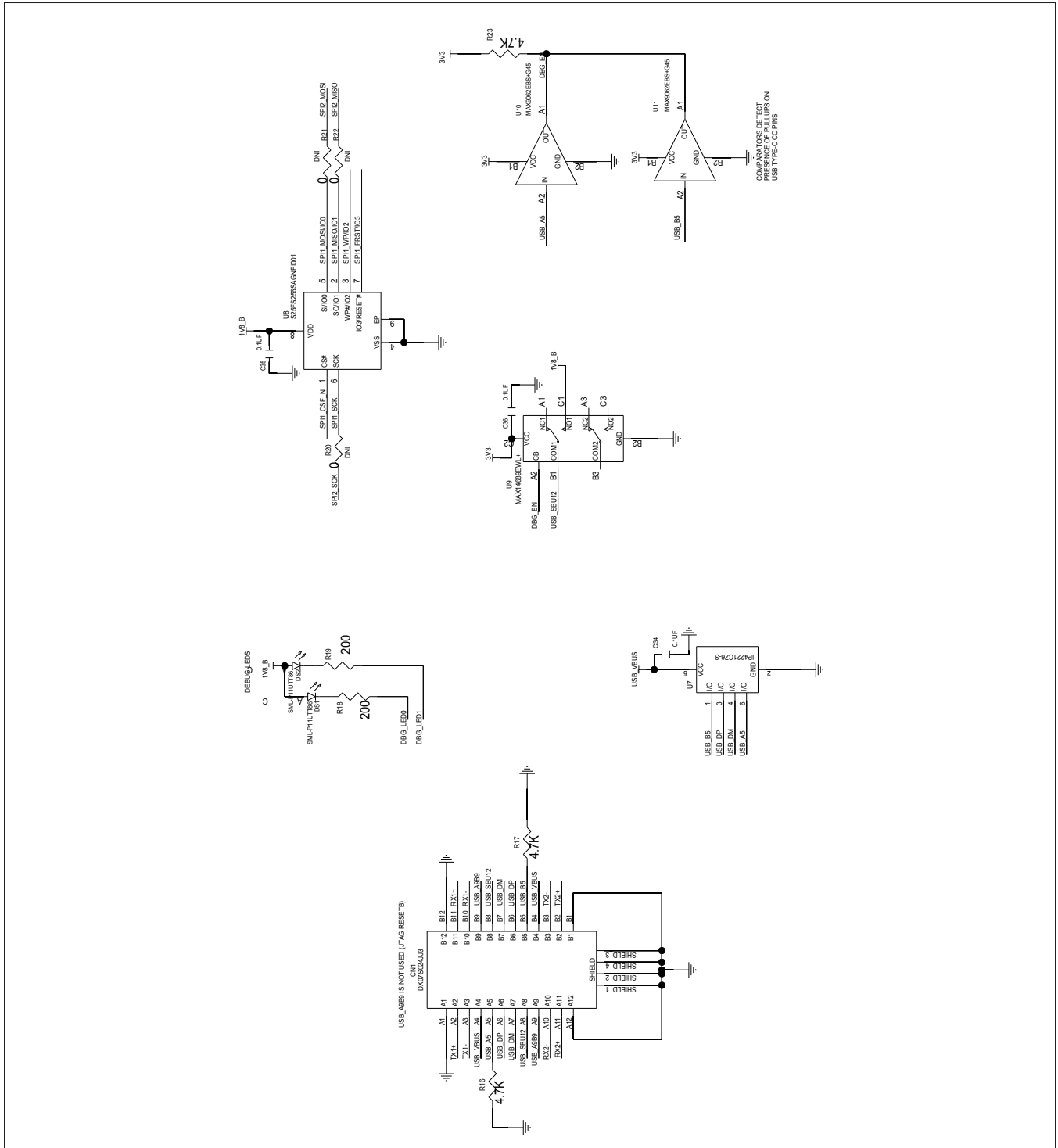
MAX86160 EV Kit Schematics

MAXSensorBLE



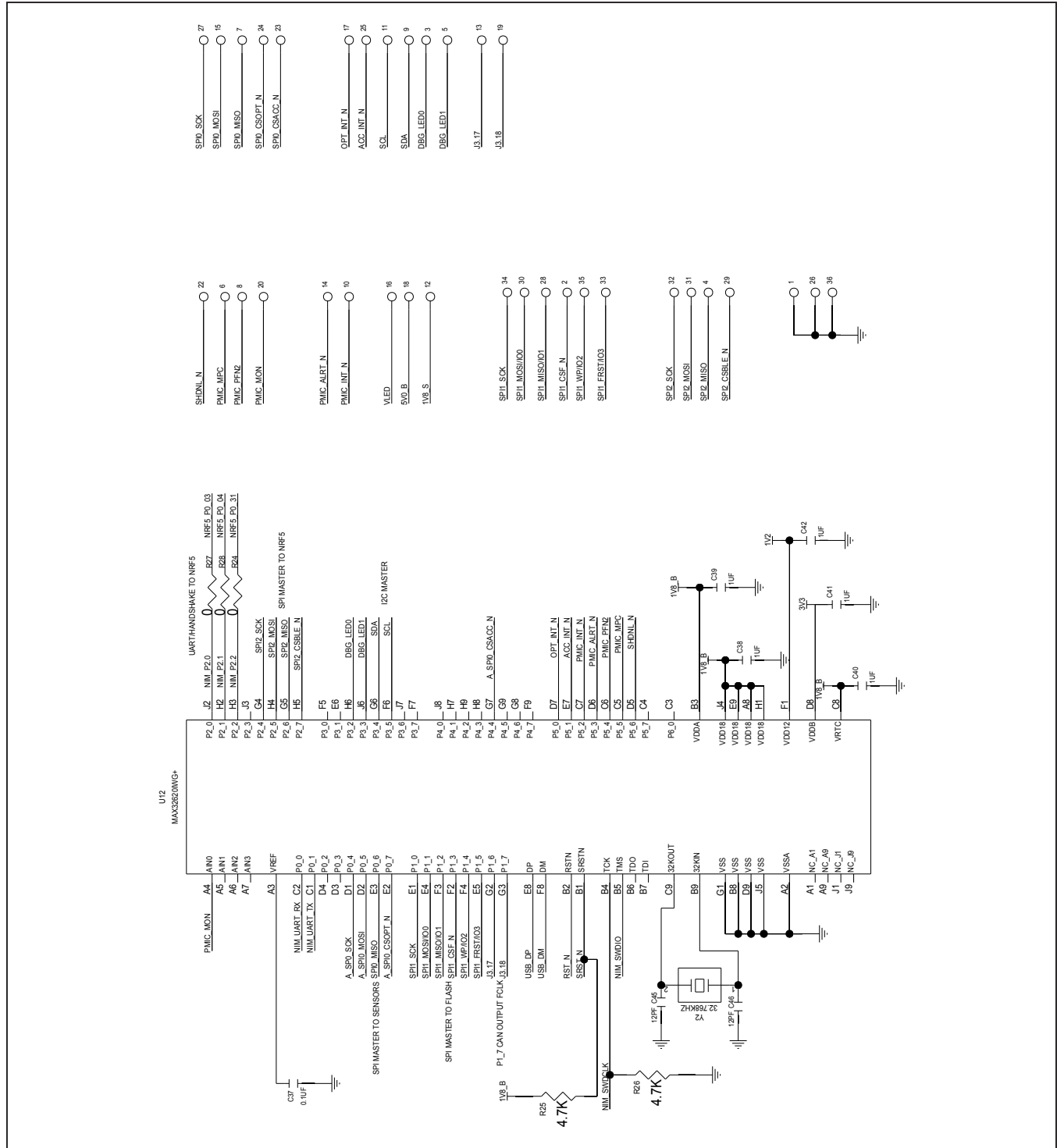
MAX86160 EV Kit Schematics (continued)

MAXSensorBLE



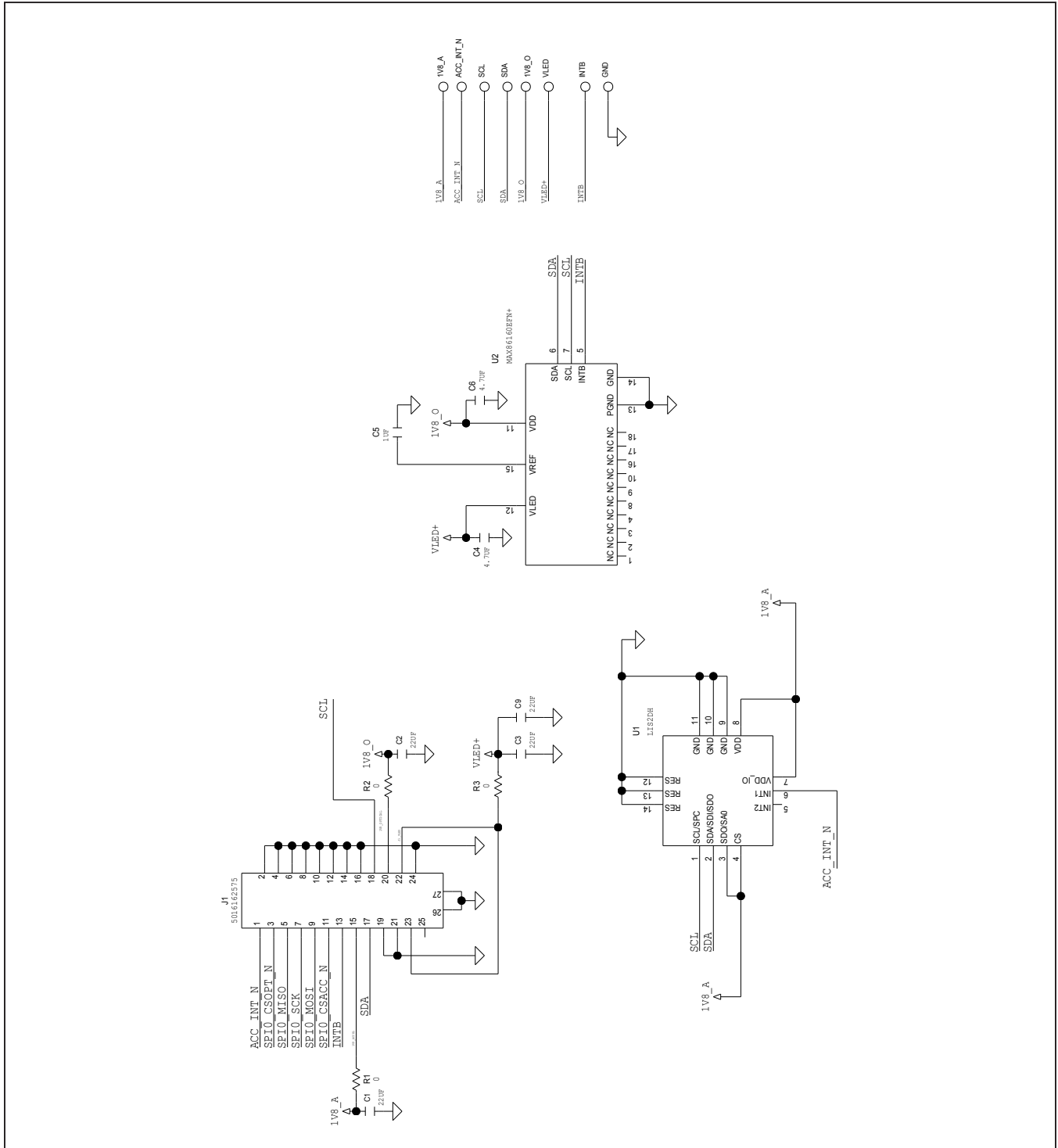
MAX86160 EV Kit Schematics (continued)

MAXSensorBLE



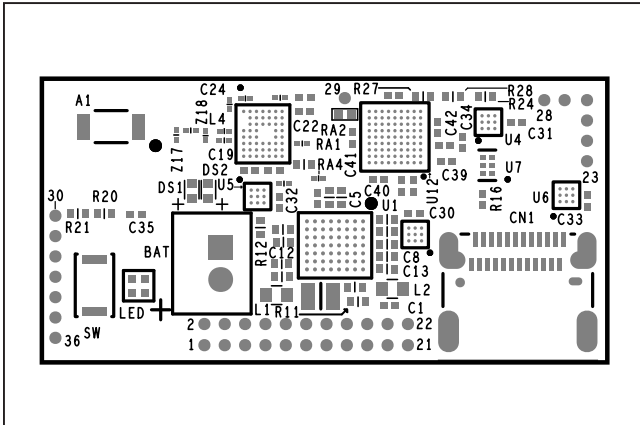
MAX86160 EV Kit Schematics (continued)

MAX86160_Flex_Bd_EVKIT

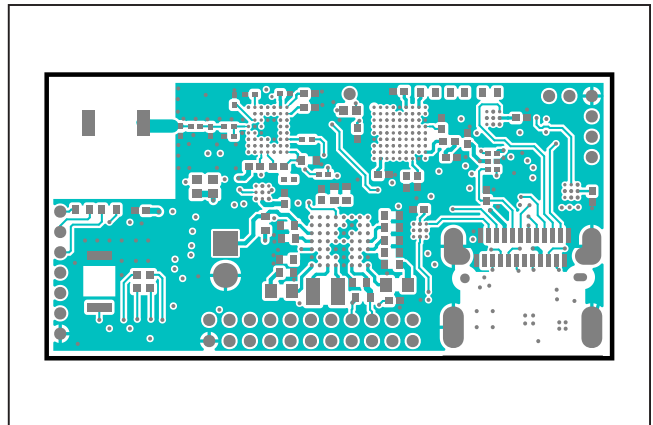


MAX86160 EV Kit PCB Layout Diagrams

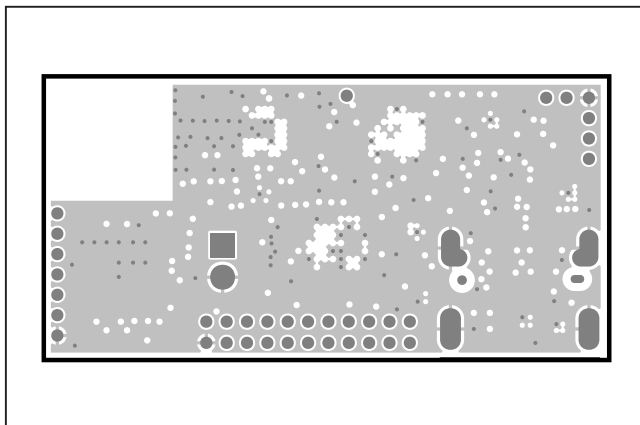
MAXSensorBLE_EVKIT



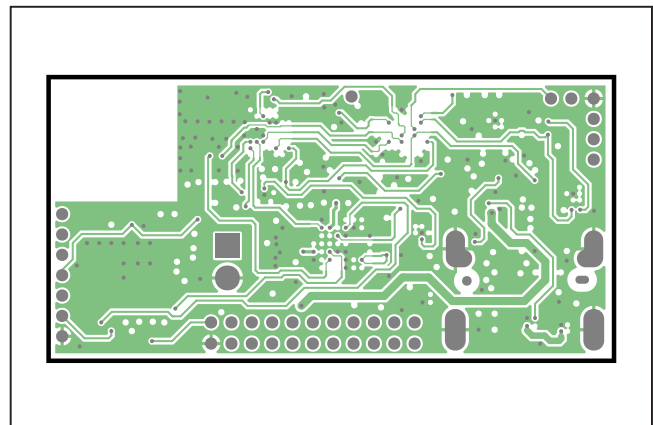
MAXSensorBLE_EVKIT—Silk_Top



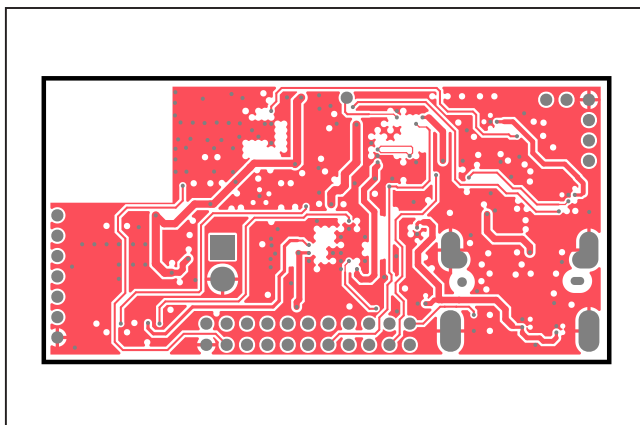
MAXSensorBLE_EVKIT—Top



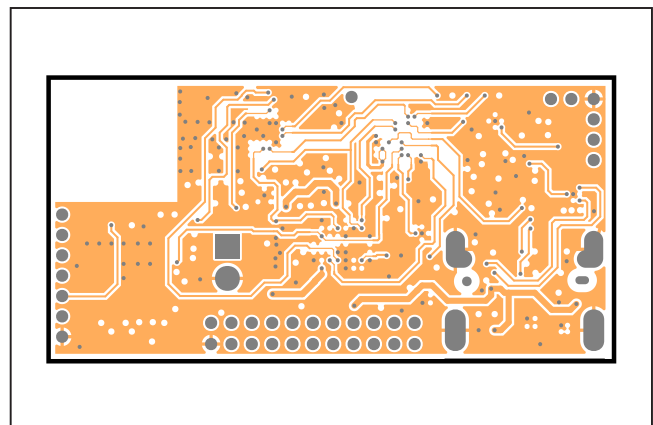
MAXSensorBLE_EVKIT—L02_GND



MAXSensorBLE_EVKIT—L03_SIGS



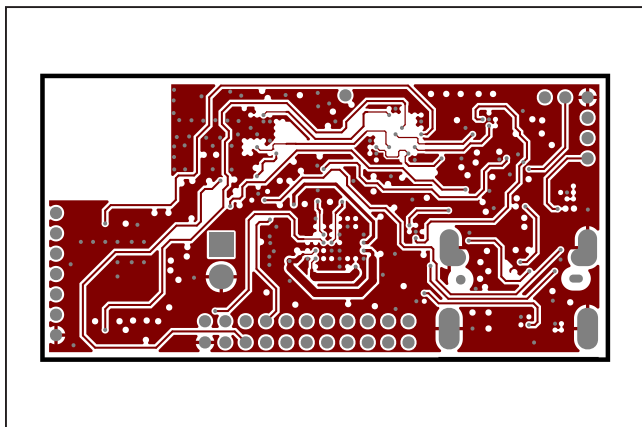
MAXSensorBLE_EVKIT—L04_SIGS



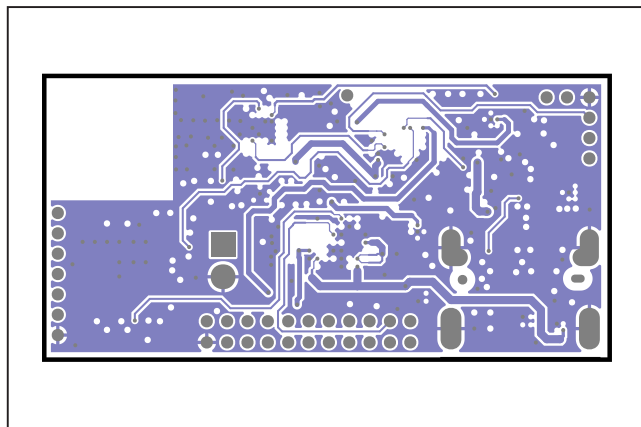
MAXSensorBLE_EVKIT—L05_SIGS

MAX86160 EV Kit PCB Layout Diagrams (continued)

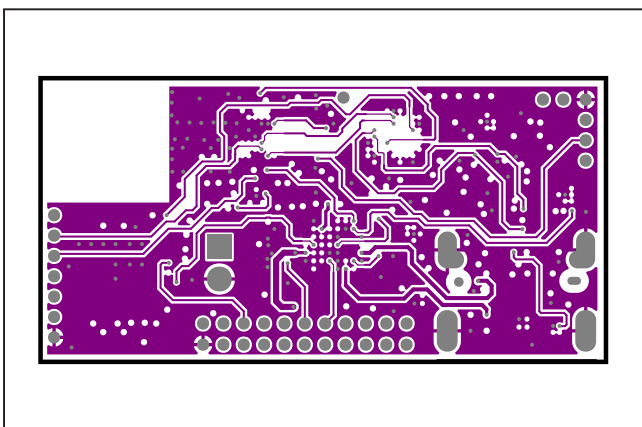
MAXSensorBLE_EVKIT



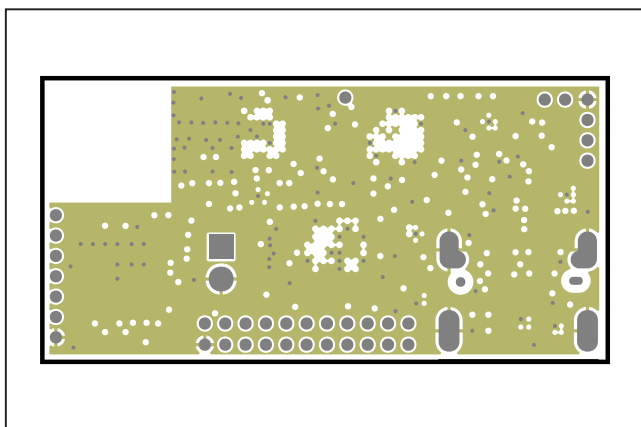
MAXSensorBLE_EVKIT—L06_SIGS



MAXSensorBLE_EVKIT—L07_SIGS



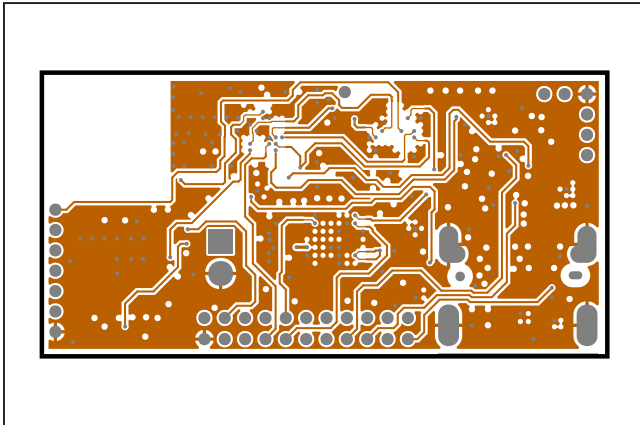
MAXSensorBLE_EVKIT—L08_SIGS



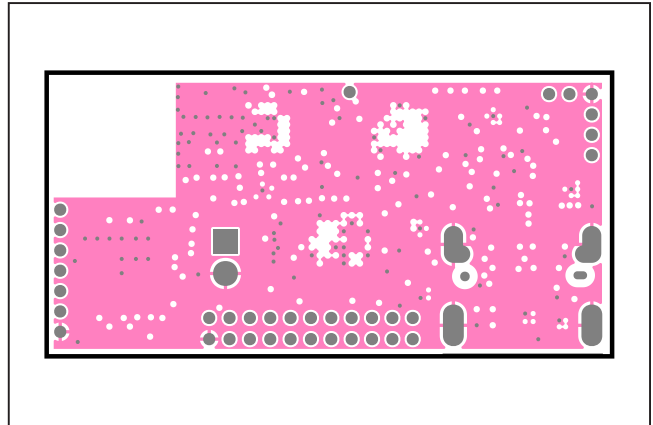
MAXSensorBLE_EVKIT—L09_GND

MAX86160 EV Kit PCB Layout Diagrams (continued)

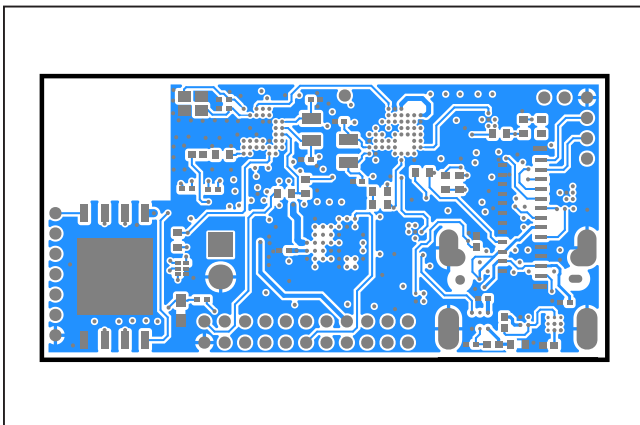
MAXSensorBLE_EVKIT



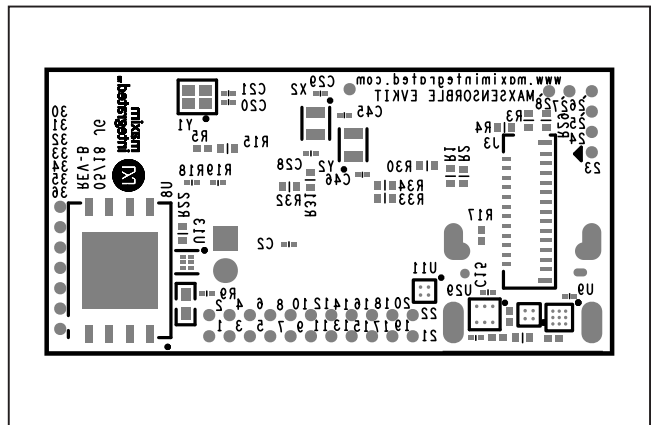
MAXSensorBLE_EVKIT—L10_SIGS



MAXSensorBLE_EVKIT—L11_GND



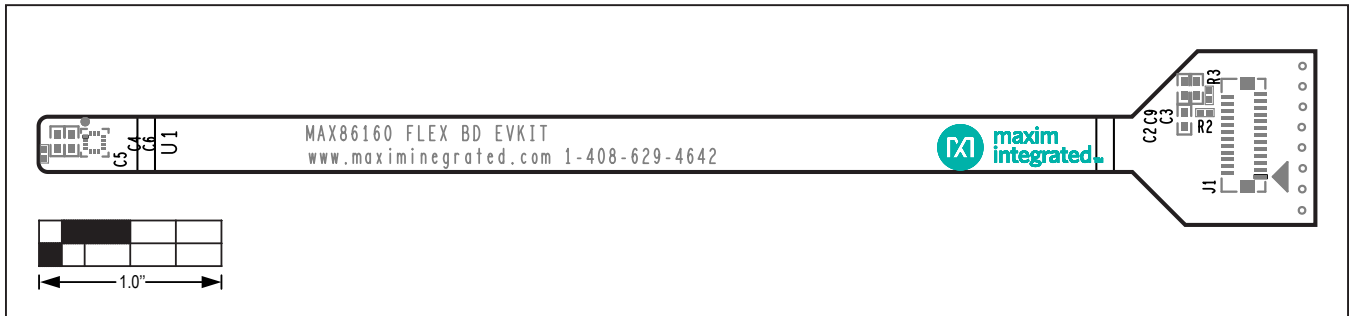
MAXSensorBLE_EVKIT—BOTTOM



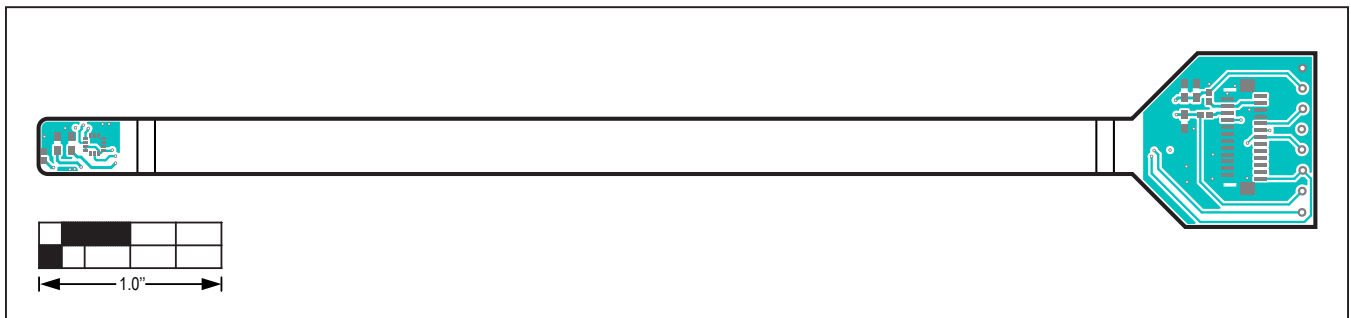
MAXSensorBLE_EVKIT—SILK_BOT

MAX86160 EV Kit PCB Layout Diagrams (continued)

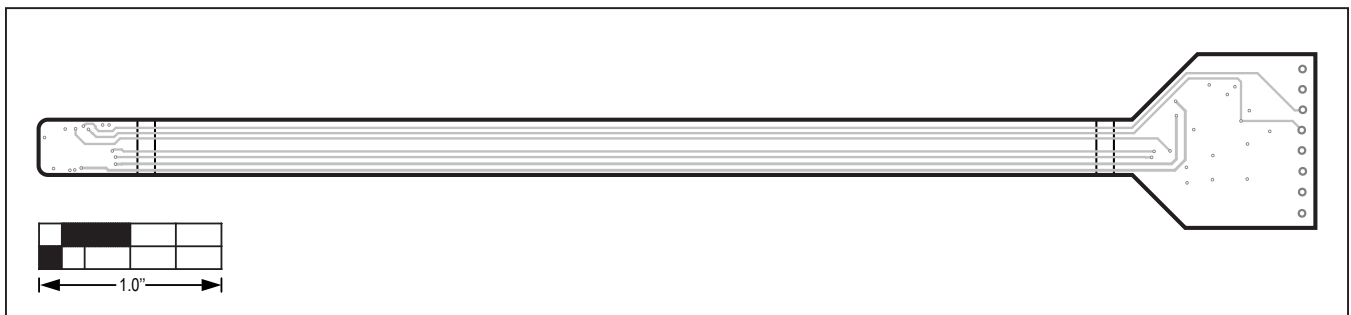
MAX86160_Flex_Bd_EVKIT



MAX86160OSBEK#—SILK_TOP



MAX86160OSBEK#—Top



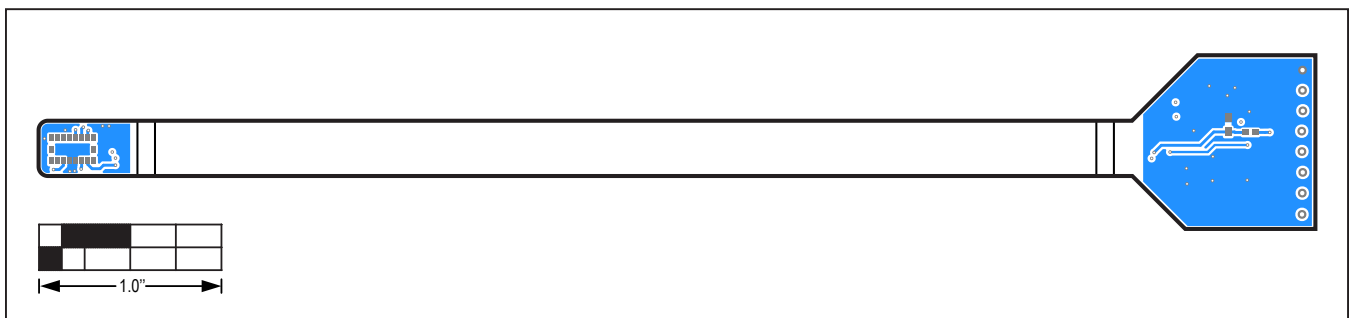
MAX86160OSBEK#—L02_GND

MAX86160 EV Kit PCB Layout Diagrams (continued)

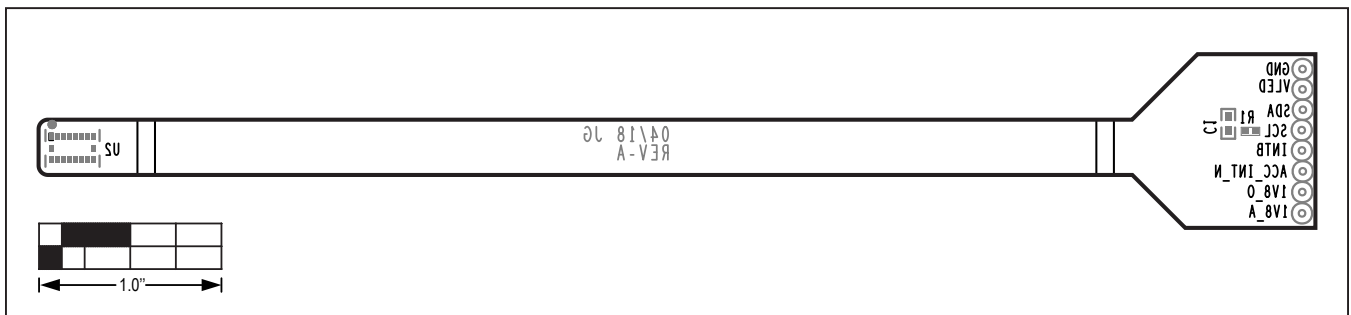
MAX86160_OSBEVKIT



MAX86160OSBEK#—L03_SIG



MAX86160OSBEK#—BOTTOM



MAX86160OSBEK#—BOTTOM_SILKSCREEN

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	8/16	Initial release	—
1	11/18	Replaced and updated all pages of the data sheet to reflect changes from an Evaluation Kit to an Evaluation System, and a microcontroller board change to a stand-alone board.	1–30

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